March Visibility Report On

- **India Softens China FDI Curbs: Growth Push Or Risky Move,**
- **Helium prices spike as Iran war disrupts supply**
- **Tata Semiconductors' business raises $735 mn from 5 banks,**
- **Pax Silica,**
- **Memory Chips & ISM 2.0**
- **Press Note 3 framework**
- **Karnataka Budget 2026**
- **Gujarat Semiconnect**
- **Micron’s ATMP facility in Sanand**

S No.	Date	Publication	Headline	Page No.	Link	AVE	Quote By
Electronic Channel							
1	11th March 26	NDTV Profit	India Softens China FDI Curbs: Growth Push Or Risky Move? The Big Question	N/A	Link	220000	Ashok Chandak, President: IESA and SEMI India
EXCLUSIVE STORY							
1	25th March,26	AEI Japan	India Executes Semiconductor Policy Into Full-Stack Growth	N/A	Link		Ashok Chandak, President: IESA and SEMI India
Individual Story							
1	13tH March	Economic Times	Chip Firms Tap Gujarat Govt for Free Trade Zone and Shared Warehouse	02	N/A	56000	
Industry Stories							
1	25th March	Deccan Chronicle	Helium prices spike as Iran war disrupts supply	10		67000	Ashok Chandak, President : IESA and SEMI India
2	25th March	New Indian Express	Helium shortage looms over electronics sector amid West Asia tensions	15		49000	Ashok Chandak , President : IESA and SEMI India
3	23rd March	Hindustan Times	Tata chip unit raises $735 mn from banks	16		54000	Ashok Chandak , President : IESA and SEMI India

4	23rd March 26	MINT	Tata semiconductors business raises $735 mn from 5 banks	11		54000	Ashok Chandak, President: IESA and SEMI India
5	20th March	Times Of India	Helium supply hit, scans may get costlier	05		55000	Ashok Chandak , President : IESA and SEMI India
6	12th March	Mint	Artificial intelligence boom making new chip problem for car firms	1, 9		87000	Ashok Chandak , President : IESA and SEMI India
Industry Stories							
Online							
1	26th March	Financial Express	Helium shortage may tighten chip supplies for user industries		Link	92000	Ashok Chandak, President: IESA and SEMI India
2	26th March	Money Control	Helium shock puts India's semiconductor, PCB push at risk due to the Iran-Israel war		Link	82000	Ashok Chandak, President: IESA and SEMI India
3	19th March	ET Manufacturing	Semicon players seek sops to meet goals		Link	86000	Ashok Chandak, President: IESA and SEMI India
4	19th March	ET Telecom	Semicon players seek sops to meet goals		Link	82000	Ashok Chandak, President: IESA and SEMI India
5	13th March	Economics	Chip firms tap Gujarat govt for		Link	95000	Ashok

		Times	free trade zone and shared warehouse				Chandak, President: IESA and SEMI India
Podcast							
1	12th March 26	ANI Podcast	Pax Silica, Memory Chips & ISM 2.0: The Next Phase of India's Semiconductor Strategy | Ashok Chandak	N/A	Link	575000	Ashok Chandak
Follow-up from ANI							
1	12th March	ANI	India's Semiconductor Journey to move towards design-led manufacturing for worldwide use, IESA President Ashok Chandak	N/A	Link	85000	Ashok Chandak, President: IESA and SEMI India
2	12th March	Public Tv	India to have capacity of 75-80 million chips per day through new semiconductor plants soon: IESA President	N/A	Link	24000	Ashok Chandak , President : IESA and SEMI India
3	12th March	The Times of India	New chip plants could raise India's output to 75–80 million per day: IESA	N/A	Link	85000	Ashok Chandak, President: IESA and SEMI India
4	12th March	Hindu Business Line	India shifts towards design-led semiconductor manufacturing, says IESA president	N/A	Link	95000	Ashok Chandak, President: IESA and SEMI India
5	12th March	The Tribune	India to have capacity of 75-80 million chips per day through new semiconductor plants soon: IESA President	N/A	Link	65000	Ashok Chandak, President: IESA and SEMI India
6	12th March	AsianNet Central	AI Boom Drives Global Memory Chip Shortage, IESA President Explains	N/A	Link	21000	Ashok Chandak, President:

							IESA and SEMI India
7	12th March	Economic Times CIO	India to have capacity of 75-80 million chips per day through new semiconductor plants soon	N/A	Link	84000	Ashok Chandak, President: IESA and SEMI India
8	12th March	Business honours	India's Semiconductor Sector to Achieve 75-80 Million Chips per Day Capacity	N/A	Link	24000	Ashok Chandak, President: IESA and SEMI India
9	12th March	Electronics for you	India Targets 75–80 Million Chips Per Day Capacity as New Semiconductor Plants Near Operations	N/A	Link	55000	Ashok Chandak, President: IESA and SEMI India
10	12th March	English Public TV	India to have capacity of 75-80 million chips per day through new semiconductor plants soon: IESA President	N/A	Link	22000	Ashok Chandak, President: IESA and SEMI India
11	12th March	Lokmat	India's semiconductor journey to move towards design-led manufacturing for worldwide use: IESA President Ashok Chandak	N/A	Link	60000	Ashok Chandak, President: IESA and SEMI India
12	12th March	WebIndia 123	India to have capacity of 75-80 million chips per day through new semiconductor plants soon: IESA President	N/A	Link	21000	Ashok Chandak , President : IESA and SEMI India
13	12th March	New Kerala	India to Produce 75-80 Million Chips Daily as New Semiconductor Plants Ramp Up	N/A	Link	22000	Ashok Chandak , President : IESA and SEMI India
14	12th March	Kerala Business News	India’s chip output may hit 80 million daily by 2026	N/A	Link	21000	Ashok Chandak , President :

							IESA and SEMI India
15	12th March	Latestly	Business News | India's Semiconductor Journey to Move Towards Design-led Manufacturing for Worldwide Use: IESA President Ashok Chandak	N/A	Link	20000	Ashok Chandak , President : IESA and SEMI India
16	12th March	MSN	New chip plants could raise India's output to 75–80 million per day: IESA	N/A	Link	20000	Ashok Chandak , President : IESA and SEMI India
17	12th March	Trendforce	India's Chip Output Set to Reach 75–80 Million Units per Day, Marking a New Milestone	N/A	Link	23000	Ashok Chandak , President : IESA and SEMI India
18	12th March	Newsable	India's semiconductor ecosystem to produce 80M chips per day: IESA	N/A	Link	22000	Ashok Chandak , President : IESA and SEMI India
S No.	**Date**	**Publication**	**Headline**	**Page No.**	**Link**	**AVE**	**Quote By**
Press Note 3 framework							
Gujarat - Print							
1	13th March	Sabandh Bharat	Ashok Chandak, President – India Electronics and Semiconductor Association (IESA)	03		7000	Ashok Chandak , President : IESA and SEMI India
2	13th March	Divya Gujarat	Ashok Chandak, President – India Electronics and Semiconductor Association (IESA)	03		9000	Ashok Chandak , President : IESA and SEMI India
3	12th March	Rakhewal	Security of national methods:	04		8000	Ashok

			Ashok Chandak, President - India Electronics and Semiconductor Association				Chandak , President : IESA and SEMI India
4	11th March	Gujarat Pranam	Ashok Chandak, President – India Electronics and Semiconductor Association (IESA)	02		19500	Ashok Chandak , President : IESA and SEMI India
Press Note 3 framework							
Guwahati - Print							
1	13th March	The North East Times	'Recent policy refinements around investments a balanced step towards India's electronics manufacturing ecosystem'	02		42000	Ashok Chandak , President : IESA and SEMI India
2	13th March	The Meghalaya Guardian	'Recent policy refinements around investments a balanced step towards India's electronics manufacturing ecosystem	08		38000	Ashok Chandak , President : IESA and SEMI India
3	13th March	Sentinel	A balanced and pragmatic step towards strengthening India's electronics manufacturing ecosystem: Ashok Chandak	08		25000	Ashok Chandak , President : IESA and SEMI India
4	13th March	Gana Adhikar	Steps to strengthen India's electronics manufacturing system	06		6800	Ashok Chandak , President : IESA and SEMI India
5	13th March	Dainik Purvoday	Reforms in Investment Policy Are in the Country's Interest: Chandak	09		7800	Ashok Chandak , President : IESA and SEMI India
6	12th March	Purvanchal Prahari	Recent policy reforms regarding investment under the	06		6800	Ashok Chandak ,

			framework				President : IESA and SEMI India
Press Note 3 framework							
National - Print							
1	12th March	Financial Express	Push to electronics manufacturing	5		127316	Ashok Chandak , President : IESA and SEMI India
2	12th March	The Times Of India	FDI rejig: Global investors with small Chinese stake likely to gain	13		139064	Ashok Chandak , President : IESA and SEMI India
3	12th March	The Telegraph	Gates reopen for Chinese capital	13		499002	Ashok Chandak , President : IESA and SEMI India
4	12th March	The Hindu	Changes in FDI rules to aid rare earth Sector	15		126782	Ashok Chandak , President : IESA and SEMI India
5	11th March	Hindustan Times	Cabinet eases investment rules for china , neighbours	11		105670	Ashok Chandak , President : IESA and SEMI India
Press Note 3 framework							
National - Online							
1	11th March	Hindustan Times	Cabinet eases investment rules for China and neighbours sharing land borders with India	N/A	Link	85000	Ashok Chandak , President : IESA and SEMI

							India
2	11th March	The Telegraph	India eases FDI rules under Press Note 3 with 10 per cent cap for border country investors	N/A	Link	65000	Ashok Chandak , President : IESA and SEMI India
3	11th March	Financial Express	PN3 easing may speed electronics component manufacturing	N/A	Link	90000	Ashok Chandak , President : IESA and SEMI India
4	11th March	Times Of India	Fdi rejig global investors with small chinese stake likely to gain	N/A	Link	85000	Ashok Chandak , President : IESA and SEMI India
5	11th March	Daily Hunt	India eases FDI rules under Press Note 3 with 10 per cent cap for border country investors	N/A	Link	21000	Ashok Chandak , President : IESA and SEMI India
6	11th March	Money Control	Press Note 3 tweak, 60-day FDI nod timeline to aid electronics components ecosystem: Industry	N/A	Link	82000	Ashok Chandak , President : IESA and SEMI India
7	12th March	ET Telecom	'India's fresh FDI rules to expedite tech JV formations; caution needed in critical sectors	N/A	Link	82000	Ashok Chandak , President : IESA and SEMI India
8	11th March	Data Quest	Government push to boost electronics components manufacturing to strengthen India's semiconductor ecosystem	N/A	Link	35000	Ashok Chandak , President : IESA and SEMI India

9	11th March	Business News For Profit	Government Push to Boost Electronics Components Manufacturing to Strengthen India's Semiconductor Ecosystem	N/A	Link	22000	Ashok Chandak , President : IESA and SEMI India
10	11th March	Cine BuZZ nEWS	Government Push to Boost Electronics Components Manufacturing to Strengthen India's Semiconductor Ecosystem		Link	26000	Ashok Chandak , President : IESA and SEMI India
11	11th March	Media Bulletin News	Government Push to Boost Electronics Components Manufacturing to Strengthen India's Semiconductor Ecosystem		Link	21000	Ashok Chandak , President : IESA and SEMI India
12	11th March	Contentmedia Solution	Government Push to Boost Electronics Components Manufacturing to Strengthen India's Semiconductor Ecosystem		Link	20000	Ashok Chandak , President : IESA and SEMI India
13	11th March	Pgurus	Cabinet eases investment rules for china and neighbouring countries sharing land borders with india		Link	23000	Ashok Chandak , President : IESA and SEMI India
14	11th March	Money Control	Relaxed FDI norms to open door for more India–China electronics components, capital goods JVs		Link	82000	Ashok Chandak , President : IESA and SEMI India
15	11th March	MSN	Cabinet eases investment rules for China and neighbours sharing land borders with India		Link	20000	Ashok Chandak , President : IESA and SEMI India
S No.	**Date**	**Publication**	**Headline**	**Page No.**	**Link**	**AVE**	**Quote By**

Karnataka Budget							
Bengaluru							
1	17th March	Sanjhe Samaya	Karnataka Budget 2026 highlights electronics, semiconductor and deep-tech innovation	03	N/A	19000	Ashok Chandak , President : IESA and SEMI India
2	17th March	Udayakala	Budget 2026 highlights importance of electronics, semiconductor and deep-tech innovation: IESA	08	N/A	11500	Ashok Chandak , President : IESA and SEMI India
3	17th March	Sanje Samaya	Karnataka Budget 2026 highlights importance of electronics, semiconductor and deep-tech innovation: Ashok Chandak, President of IASAIESA, responds	03	N/A	19000	Ashok Chandak , President : IESA and SEMI India
4	17th March	Sanje Express	Karnataka Budget 2026 highlights electronics, semiconductor and deep-tech innovation	03	N/A	17000	Ashok Chandak , President : IESA and SEMI India
5	17th March	Udayakala	Budget 2026 highlights importance of electronics, semiconductor and deep-tech innovation: IESA	08	N/A	11500	Ashok Chandak , President : IESA and SEMI India
6	17th March	Suvarna Times of Karnataka	Karnataka Budget 2026 highlights importance of electronics, semiconductor and deep-tech innovation: IESA	03	N/A	18200	Ashok Chandak , President : IESA and SEMI India
7	17th March	Arambha	Budget 2026 highlights electronics, semiconductor and deep-tech innovation	02	N/A	12700	Ashok Chandak , President : IESA and SEMI India
8	17th March	Vijay Spoorthi	Investment of about Rs. 45,000	02	N/A	7900	Ashok

			crore from companies in the semiconductor and ESDM sectors				Chandak , President : IESA and SEMI India
Karnataka Budget							
Bengaluru							
1	6th March2026	Business news for profit	Karnataka Budget 2026 Reinforces the State's Leadership in Electronics, Semiconductors and Deep-Tech Innovation : IESA		Link	23000	Ashok Chandak , President : IESA and SEMI India
2	6th March2026	Contenmediaso lution	Karnataka Budget 2026 Reinforces the State's Leadership in Electronics, Semiconductors and Deep-Tech Innovation : IESA		Link	21000	Ashok Chandak , President : IESA and SEMI India
3	6th March2026	Business news this week	Karnataka Budget 2026 Reinforces the State's Leadership in Electronics, Semiconductors and Deep-Tech Innovation : IESA		Link	24000	Ashok Chandak , President : IESA and SEMI India
4	6th March2026	Bisnewsdeskme dia solution	Karnataka Budget 2026 Reinforces the State's Leadership in Electronics, Semiconductors and Deep-Tech Innovation : IESA		Link	21000	Ashok Chandak , President : IESA and SEMI India
5	6th March2026	Mediabulletin	Karnataka Budget 2026 Reinforces the State's Leadership in Electronics, Semiconductors and Deep-Tech Innovation : IESA		Link	20000	Ashok Chandak , President : IESA and SEMI India

ELECTRONIC CHANNEL

Date	28th March
Publication	NDTV Profit
Link	https://www.youtube.com/watch?v=E_giPC_7YBI

India Softens China FDI Curbs: Growth Push Or Risky Move? The Big Question

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EXCLUSIVE STORY

Online

Date	28th March
Publication	AEI Japan
Link	India Executes Semiconductor Policy Into Full-Stack Growth | AEI

India Executes Semiconductor Policy Into Full-Stack Growth

In this exclusive interview, IESA President Ashok Chandak explains how policy momentum is translating into manufacturing reality, capital efficiency, and long-term ecosystem competitiveness—and why global chipmaker are starting to take India seriously now.

For many decades, India's role in the global semiconductor industry was anchored in its powerhouse engineering talent and design capabilities. Today, that role is deliberately evolving with the rise of domestic semiconductor fabs.

India is no longer positioning itself solely as a design hub or a large consumption market. Instead, it is undertaking a decisive transition towards a full-stack electronics and semiconductor ecosystem, carving its own relevance in global manufacturing and supply chains.

Thanks to sound government initiatives, such as the India Semiconductor Mission (ISM), Production Linked Incentives (PLI), and the Electronic Component Manufacturing Scheme (ECMS), India is now translating these policies into actual fabs, OSATs, components manufacturing facilities, and other infrastructure. The country's roadmap now emphasizes high volume semiconductor nodes, packaging, and other value addition activities while further leveraging its advanced capabilities in design, R&D, and IP creation.

Ashok Chandak, President, India Electronics & Semiconductor Association (IESA)

Individual Story

Print

Date	13rd March
Publication	Economics Times
Quote By	Ashok Chandak

Chip Firms Tap Gujarat Govt for Free Trade Zone and Shared Warehouse

Applied Materials, Lam, KLA, Micron, Kaynes, CG Semi make representations to govt

Suraksha P & Dia Rekhi

Bengaluru | Ahmedabad: Semiconductor equipment makers, memory storage suppliers and companies that specialise in chip packaging and testing have approached the Gujarat government, requesting setting up of an exclusive free trade zone and shared warehousing infrastructure for the sector, people in the know told ET.

These companies include Applied Materials, Lam Research, KLA, Micron, Kaynes Semicon and CG Semi. They are establishing, or supplying equipment for, large semiconductor and related facilities in Gujarat, especially at the industrial belt of Sanand and Dholera where Tata Electronics is setting up India's first fabrication plant.

Analysts said having a free trade zone will allow companies to import, assemble and store equipment locally without paying import duties, making logistics smoother and enabling more efficient global supply chain operations. "We have got representations from Micron and CG Semi. The government is actively working with the industry for the same," a Gujarat government official told ET. "Micron has already been given approval for the SEZ and the representations from industry have mainly been about the shared warehousing and SEZ status."

Kaynes Semicon chief executive Raghu Panicker said the outsourced semiconductor assembly and test (OSAT) company already has approval for a special economic zone (SEZ) at Sanand. "We are not looking at a separate FTZ (free trade zone)," he said, but added that it would partner with other companies for a shared warehouse.

FOR FULL REPORT, GO TO www.economictimes.com

EASING THE WAY

Having a free trade zone will allow cos to import, assemble and store equipment locally without paying import duties

Individual Story

Print

Date	23rd March
Publication	Mint
Quote By	Ashok Chandak

Tata semiconductor business raises $735 mn from 5 banks

FROM PAGE 1

Bank, ₹1,697 crore from DBS, and the remaining ₹1,146 crore from ANZ. These foreign banks used their branches in Gandhinagar's GIFT City, allowing Tatas to access cheaper interest rates.

Some of these loan terms have been dubbed "unconventional" by two executives privy to the developments, who suggested that the banks agreed to lend to the Tata Group company because of the conglomerate's brand name.

"The banks' credit decision is based on Tata's global creditworthiness, and not the land valuations," said one of the two executives at Tata Group cited above. "The banks want the continued association of the Tata Group, hence leading to some of the clauses on the Tata brand name, and for the Group to retain majority control. The land mortgage is just the legal requirement that gives banks the right to step in."

Most lenders will cash in on the semiconductor industry given its potential, said Harshit Kapadia, vice-president of brokerage Elara Capital. "Raising debt from banks will be key for initial project buildout until a project gets a government subsidy. Plus, an established electronics manufacturer like Kaynes, Dixon or the Tatas, which have also already won government backing, will see strong interest from banks since their reputation and government subsidies themselves act as strong collaterals for them," Kapadia said. "But, banks may add equity clauses in such loans because these funds use the companies' reputations as guarantees, and a chip plant's success is contingent upon many technical challenges."

The Tatas are required to invest only ₹35,400 crore. BLOOMBERG

A representative for Tata Electronics said the company "does not have an update" to share. An HSBC representative declined to comment. Queries sent to the four other banks remained unanswered.

Tata Electronics has put about ₹690 crore in TSML since it was set up in November 2023. The 5 February loan agreement with the foreign banks implied Tata Group would need to infuse more capital into the company to comply with its creditors' requirement to maintain 30% equity, against its current borrowing of ₹6,835 crore.

Tata Sons has invested over $1 billion in its iPhone assembly business, Tata Electronics, since starting it in 2020.

Tatas, in partnership with Taiwanese semiconductor manufacturer Powerchip, expects to start trial production by the first half of next year, with a capacity of 50,000 microchips per month.

"The Tata chip fab's construction has progressed at a steady pace, and some incidental delays are usual in such large projects. But, much of a chip fab's success will depend on the first trial production phase of chips, which will happen only once the fab's 'clean room' is equipped. If there are any issues on semiconductor purity or multiple other technical factors, the commercial functioning of the fab can be hampered," said Ashok Chandak, president of industry body, India Electronics and Semiconductor Association.

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For an extended version of this story, go to livemint.com

Date	2 March
Publication	Mint
Quote By	Ashok Chandak

Artificial intelligence boom making new chip problem for car firms

FROM PAGE 1

above said on the condition of anonymity.

The issue was earlier flagged to analysts by Mahindra and Mahindra Ltd (M&M), which makes electric cars, and e-two-wheeler manufacturer Ather Energy Ltd.

"Memory chips are something that is a supply chain risk/price sensitive thing because shortage obviously is driving premiums in memory chips," M&M executive director Rajesh Jejurikar told analysts and investors on an 11 February earnings call. "So, a memory chip is something which is a watch-out across the portfolio right now. That's the new rare, rare earth, let's call it that."

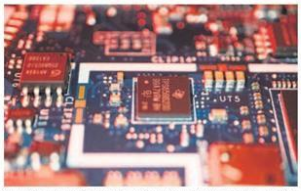
However, Jejurikar assured that the situation was currently under control. "We are buying in the market, we are paying a premium and we have a set of mitigating actions," he said. "We are covered in the short run but it's almost like going back to semiconductors of covid... the risk could be quite severe."

Then, last week, during a meeting with analysts of Nuvama Institutional Equities, Bengaluru-based Ather Energy's management highlighted memory chips' inflation owing to supply crunch as one of the near-term headwinds to the business.

Queries sent to automakers Maruti Suzuki, Tata Motors PV, Hyundai Motor India, Ola Electric, Hero MotoCorp, Honda Motorcycle and Scooter India, Bajaj Auto, TVS Motor Company and auto suppliers like Samvardhana Motherson, Sona Comstar, and Bosch remained unanswered till press time.

Manufacturers such as Micron Technology in the US and South Korea's Samsung and SK Hynix have started focusing most of their manufacturing lines on making HBM chips, used in graphic processing units that Nvidia sells for AI data centres.

"There is definitely a shortage of DRAM and NAND chips (memory chips used in vehicles) in the market, which is likely to affect the automotive industry all through 2026, and at least partially in 2027 as well," Ashok Chandak, president, India Electronics and Semiconductor Association, said.



As chipmakers shift manufacturing capacity toward HBM, supplies of conventional memory chips used in cars are tightening. REUTERS

"This could also be amplified by large tech firms pushing chip supply chains to cater to their AI demand, and large industrial conglomerates over-ordering and advance-ordering memory chips for industrial uses, which could affect small auto firms," he added.

The older generation chips, used by automakers, are not being prioritized for production, which is leading to a supply crunch and high prices.

Memory chips in vehicles, while minuscule in share of overall content, are nonetheless critical as they help in storing and accessing data, and are used in infotainment systems, advanced driver assistance systems, engine control units, and battery management systems, among others. A shortage of such chips risks putting vehicle production out of gear.

CHIP HUNT

THE move could mark the third major supply disruption for the auto industry in recent years

IF supply pressures persist, automakers may start facing shortages by the end of the next fiscal year

"With the current supply chain catering heavily to HBM chips, the market is skewered because HBM chips have much larger die sizes, lower yields, and require advanced packaging, which means that they take longer to make," Kanishka Chauhan, senior principal analyst of emerging trends and technologies at Gartner, said, adding that HBM chips are also more expensive and provide better margins and returns for chipmakers.

"Over time, there is likely to be a concerted push to move industrial systems to newer generation memory chips, which is in line with the cyclical process in which this industry works. Until this cycle resolves, there is likely to be a cycle of supply shortage for all kinds of memory but especially the legacy memory chips," he added.

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For an extended version of this story, go to livemint.com.

Date	23rd March
Publication	Hindustan Times
Quote By	Ashok Chandak

Tata chip unit raises $735 mn from banks

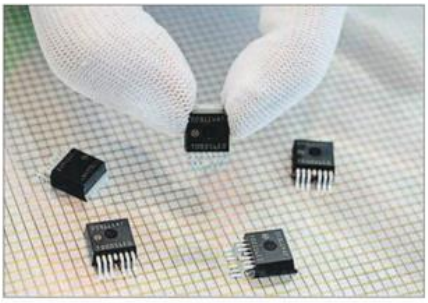
Dholera land zero-valued; banks want Tatas to retain 51% stake in TSML

Shouvik Das & Varun Sood
shouvik.das@livemint

NEW DELHI/BENGALURU: Tata Semiconductor Manufacturing Pvt. Ltd (TSML) has raised ₹6,835 crore (about $735 million) from five foreign banks to fund its ₹91,000 crore semiconductor fabrication facility in Gujarat. The lenders have put conditions on ownership, branding and equity that reflect their reliance on the Tata Group's credit profile and the tight financing terms shaping India's chip manufacturing push, according to company filings and executives aware of the matter.

The lenders have stipulated that the Tatas retain a 51% stake in TSML, the wholly owned subsidiary of the privately held Tata Electronics, and continue using the 'Tata' brand, according to documents filed with the ministry of corporate affairs. The loan is to be repaid by 2031. They also mandate the company to maintain at least ₹30 crore in equity for every ₹70 crore of borrowing.

Significantly, the Gujarat government's 163.5-acre land leased to Tata Electronics on a long-term basis has been valued at zero, according to the corporate affairs ministry filings reviewed by *Mint*. This appears to be because the land, about 120-km southwest of the state capital Gandhinagar, is an undeveloped area designated for industrial development. However, Tatas have pledged this land to the five banks to raise funds for their fab unit in a deal signed on 5 February, 2026.



Tata Electronics has put about ₹690 crore in TSML since it was set up in November 2023. AFP

TSML raised ₹1,743 crore from HSBC, ₹1,147 crore from MUFG, ₹1,102 crore from First Abu Dhabi Bank, ₹1,697 crore from DBS, and the remaining ₹1,146 crore from ANZ. These foreign banks used their branches in Gandhinagar's GIFT City, allowing Tatas to access cheaper interest rates. Some of these loan terms have been dubbed "unconventional" by two executives privy to the developments, who suggested that the banks agreed to lend to the Tata Group company because of the conglomerate's brand name.

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Tata Sons has invested over $1 billion in its iPhone assembly business, Tata Electronics, since starting it in 2020.

Tatas, in partnership with Taiwanese semiconductor manufacturer Powerchip, expects to start trial production by the first half of next year, with a capacity of 50,000 microchips per month.

"The Tata chip fab's construction has progressed at a steady pace, and some incidental delays are usual in such large projects. But, much of a chip fab's success will depend on the first trial production phase of chips, which will happen only once the fab's 'clean room' is equipped. If there are any issues on semiconductor purity or multiple other technical factors, the commercial functioning of the fab can be hampered," said Ashok Chandak, president of industry body, India Electronics and Semiconductor Association.

Date	20 March
Publication	Times Of India
Quote By	Ashok Chandak

Helium supply hit, scans may get costlier

Veena Mani & Rupali Mukherjee | TNN

Bengaluru/ New Delhi: The impact of the Israel-Iran war is spreading like a contagion across different sectors. Its latest fallout is the disruption in supply of the noble gas helium which is used right from conducting MRI tests to making semiconductors.

With barely 15-20 days of inventory left, manufacturers warn of disruptions in availability to hospitals. Reduced supply and higher costs will mean pricier scans and diagnostic delays, warns the healthcare industry.

"Qatar contributes nearly one-third of helium's global supply. Any sustained disruption will have a direct bearing on MRI services and allied applications around the globe and early price signals are concerning," Medical Technology Association of India chairman Pavan Choudary told **TOI**.

15-20 DAYS OF INVENTORY LEFT

- **Helium** is used right from **conducting MRI tests to making semiconductors**
- **With barely 15-20 days of inventory left,** manufacturers warn of disruptions in supplies to hospitals in the country
- **A byproduct of natural gas processing,** helium moves with LNG output
- **Helium prices could spike by 50–200%** in severe shortage scenarios, according to Fitch
- The **semiconductor** industry estimates **indicate a sharp short-term price spike of 35–50%,** with further increases ranging between 25–50% possible over the next one to three months

A byproduct of natural gas processing, helium moves with LNG output.

Fitch said in its recent note on the situation that spot helium prices could spike by 50–200% in severe shortage scenarios, while contract prices are typically more stable but could still rise 20-40% on renegotiation. "Even so, the impact on overall cost of goods sold should be modest for larger manufacturers because helium generally comprises around 0.5%-1% of production costs," the agency said, talking about the impact on manufacturers globally.

"Input costs have risen around 30% and freight has nearly doubled amid war-risk surcharges, compounded by gas shortages, putting significant pressure on the industry," said Poly Medicure MD Himanshu Baid.

Used to cool MRI magnets, hospitals and imaging centres are bracing for tighter supplies as inventories remain thin and global logistics remain volatile. Several companies have moved to developing helium-free MRI machines over the years. Siemens Healthcare MD Hariharan Subramanian said: "We have already introduced helium-free MRIs with proactive adoption of drycool technology. This helium-efficient approach reduces dependency on the gas and minimises service disruptions."

The pressure is compounded by a shortage of industrial gas used in boilers and rising energy costs, forcing companies to rely on more expensive diesel or power alternatives. A sharp escalation in the prices of key medical-grade plastics is compounding pressure on the industry.

In March alone, the cost of widely used polymers such as ABS has climbed from about Rs 140 a kg to nearly Rs 190, while SAN has risen from Rs 135 to Rs 180. Polycarbonate has jumped to around Rs 240 per kg and polypropylene, from which a large range of disposables are made, has increased from roughly Rs 103 to Rs 147 per kg.

The semiconductor industry estimates indicate a sharp short-term price spike of 35–50%, with further increases of 25–50% possible over the next one to three months if supply constraints persist.

Helium plays a vital role in semiconductor fabrication, particularly in wafer cooling, leak detection and maintaining ultra-high purity environments. Its unique physical properties make it difficult to replace, especially in advanced chip manufacturing nodes where precision and contamination control are crucial.

"Helium is a critical input in semiconductor manufacturing and there are limited substitutes in advanced fabrication processes. Supply disruptions and price volatility could impact production costs globally," said Ashok Chandak, president of the India Electronics and Semiconductor Association.

Date	25th March
Publication	Deccan Chronicle
Quote By	Ashok Chandak

Helium prices spike as Iran war disrupts supply

SANGEETHA G.
CHENNAI, MARCH 24

The Iran conflict and the recent strike on QatarEnergy's helium facility have disrupted global supplies of helium—a critical input in semiconductor manufacturing—raising concerns about potential chip shortages.

Helium, a byproduct of natural gas processing, plays a vital role in semiconductor production, particularly in high-tech fabrication processes and Qatar accounts for one-third of global helium supply.

It is used for wafer cooling, leak detection in sealed components, and as a shielding and atmospheric control gas. The gas is also essential for advanced electronics, sensors, and RF devices, making it indispensable across multiple stages of chip manufacturing.

The disruption has already triggered a spike in helium spot prices, reflecting tightening supplies.

Semiconductor manufacturers typically maintain buffer inventories that can last between one to three months, depending on operational scale and supply chain arrangements.

Some facilities also recycle helium, providing limited relief in times of supply stress, said Ashok Chandak, president of indsutry body India Electronics and Semiconductor Association.

In response to earlier global supply chain disruptions, semiconductor companies have significantly strengthened their sourcing strategies.

Over the past few years, firms have diversified suppliers and built more resilient procurement systems for critical inputs such as gases and chemicals. This preparedness is expected to cushion the immediate impact of the current disruption.

While Qatar has been a key supplier due to cost advantages and reliable output, alternative sources of helium are available globally. Companies are now exploring these options, though shifting supply chains may involve higher costs.

Despite these challenges, Chandak does not foresee a repeat of the pandemic-era semiconductor shortage as the current disruption is more localised. Production capacities in other regions remain operational, and supply routes, though strained, are still functional.

That said, short-term tightness in supply cannot be ruled out. Certain sectors may see delays or cost pressures as companies adjust to the evolving supply scenario. The global semiconductor ecosystem, which spans design, fabrication, assembly, and testing across multiple countries, remains vulnerable to geopolitical tensions and logistical disruptions.

"Electronics manufacturing could face some pressure if there is a disturbance of the semiconductor manufacturing and supplies. All our sectors, be it automotive, telecom, consumer, mobile, everything is dependent on the import of semiconductors," he said.

Chandak emphasised that the industry's interdependence acts as a stabilising factor. With multiple countries contributing to different segments of the value chain—from raw materials to final electronics—complete decoupling is neither practical nor desirable. Instead, global cooperation and diversification are likely to mitigate risks.

If geopolitical tensions persist or escalate, there could be broader implications for trade flows, raw material availability, and technology access.

COLLATERAL DAMAGE

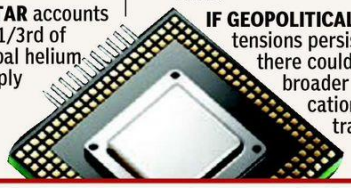
HELIUM, a byproduct of natural gas processing, plays key role in semiconductor production.

QATAR accounts for 1/3rd of global helium supply

GAS is indispensable across multiple stages of chip manufacturing.

COMPANIES exploring other options, though shifting supply chains may involve higher costs.

IF GEOPOLITICAL tensions persist, there could be broader implications for trade flows.



Semiconductor manufacturers typically maintain buffer inventories that can last between one to three months, depending on operational scale and supply chain arrangements.

— **ASHOK CHANDAK,** *president, IESA.*

Date	25th March
Publication	New Indian Express
Quote By	Ashok Chandak

Helium shortage looms over electronics sector amid West Asia tensions

SANAL SUDEVAN @ Chennai

FOLLOWING Iran's attack on Qatar's Ras Laffan LNG hub on March 19, which caused extensive damage, India's semiconductor and printed circuit board (PCB) industry is bracing for potential disruption in helium supplies—a key byproduct of liquefied natural gas (LNG). The development comes at a time when India is aggressively positioning itself as a global manufacturing hub for semiconductors and electronics.

Helium is a critical and non-substitutable input in semiconductor manufacturing processes. Eswara Rao Nandam, MD and CEO of Polymatech Electronics, said the situation has not yet escalated into a full-blown shortage but is evolving into a strategic supply concern.

"The situation is not yet a full-scale shortage but it is clearly evolving into a strategic supply concern. While Indian semiconductor and PCB players are not facing immediate production stoppages, the industry is transitioning into a precautionary and risk-managed mode," he said. Bengaluru-based Aimtron Electronics, which operates in PCB assembly and the broader electronics system design and manufacturing (ESDM) space, said short-term disruptions could affect semiconductor fabrication, testing environments, and other high-precision processes, with ripple effects across the ecosystem.

Mukesh Vasani, chairman and MD of Aimtron Electronics, noted that early signs of price volatility and supply tightening are already being closely tracked by global chipmakers. Nandam added that helium prices have surged sharply, in some cases rising 50–100% in the spot market within a short span. Ashok Chandak, president of the India Electronics and Semiconductor Association, said the crisis in Qatar has triggered a short-term price rise of 35–50%, with further upward pressure likely if disruptions persist. However, he pointed out that helium is not widely used in India's PCB assembly segment due to its high cost compared to nitrogen. "Companies may not see an immediate impact on production, but project timelines and equipment commissioning are beginning to face indirect pressures," Nandam added.

Shortage of specialised ceramic materials is adding to the strain on India's electronics sector. Multilayer ceramic capacitors (MLCCs), a key component used in smartphones, laptops, and automotive electronics, are particularly affected.

Individual Story

Online

Date	26th March
Publication	Financial Express
Link	https://www.financialexpress.com/policy/economy/helium-shortage-may-tighten-chip-supplies-for-user-industries/4185262/

Helium shortage may tighten chip supplies for user industries

A massive helium shortage triggered by Iranian strikes on Qatar's Ras Laffan facility has removed 30-38% of the world's supply, doubling spot prices overnight.

Written by Ojasvi Gupta

March 26, 2026 21:23 IST

West Asia Crisis Shuts Down 1/3rd of Global Supply, Threatening April Chip Prices

A global helium supply disruption triggered by the West Asia crisis is beginning to add pressure on the semiconductor supply chain, with potential spillovers for electronics manufacturers that rely on chips, even as India's nascent fabrication units remain largely insulated for now.

Helium, a critical industrial gas used in semiconductor manufacturing, has seen supply constraints following disruptions in Qatar, which accounts for a significant share of global output. The immediate impact on India's chipmaking ecosystem is limited, as large-scale fabrication facilities are yet to ramp up production. However, industry executives said prolonged disruption could tighten chip availability for downstream sectors such as smartphones, laptops and consumer electronics.

ALSO READ
Nayara Energy hikes petrol price by Rs 5 per litre, diesel by Rs 3

Faisal Kawoosa, chief analyst at Techarc, said pricing pressures were already building due to memory shortages, and the helium disruption could add to costs. "Prices have already been increasing for various reasons, mainly due to memory shortages. Now, with the West Asia crisis impacting helium supply, we expect another round of price increases starting early April," he said.

Date	19th March
Publication	ET Manufacturing
Link	https://manufacturing.economictimes.indiatimes.com/news/hi-tech/semicon-players-seek-sops-to-meet-goals/129669342?utm_medium=sectionListing&utm_source=top_new

Hi-Tech · 3 Min Read

Semicon players seek sops to meet goals

Semiconductor firms are urging the government for financial aid, including subsidies and tax breaks, to bolster India's semiconductor ecosystem beyond just manufacturing plants.

Suraksha P · ETtech
Published On Mar 19, 2026 at 08:12 AM IST

Companies like Inox Air Products highlight the need for a dedicated materials localisation policy to support critical upstream suppliers.

Companies related to semiconductors have sought financial incentives, such as capital subsidies and rebates on power and taxes, to help achieve the stated goals of the second phase of the India Semiconductor Mission (ISM), underscoring the criticality of building a broader ecosystem beyond fabs.

Inox Air Products, for instance, sought a dedicated semiconductor materials localisation policy within the next six months.

Ashok Chandak, president of Semiconductor Equipment and Materials International (SEMI) India, said, "Momentum is now naturally extending to the materials, gases, and supply chain ecosystem. As demand gets anchored, opportunities for localisation and co-location are becoming both viable and attractive."

Similarly, Rajoo Goel, secretary general of the Electronic Industries Association of India, said, "A reliable and adequate value chain of specialised chemicals and gases is critical for the success of the ISM. Capital equipment, tooling, and servicing are equally critical."

He added that such investments depend on sufficient demand visibility.

He noted that the government's initial focus on fabs, OSATs, and design under ISM 1.0 was necessary to create that demand base. "We do expect that the ISM 2.0 will offer attractive incentives to the companies setting up such units," he said.

Goel added that states are also likely to play a key role by topping up central incentives, as seen in earlier semiconductor approvals.

Date	19th March
Publication	ET Telecom
Link	https://telecom.economictimes.indiatimes.com/news/devices/semicon-players-seek-sops-to-meet-goals/129669275

Devices · 3 Min Read

Semicon players seek sops to meet goals

Industry experts say the next phase of policy evolution, ISM 2.0, is expected to address precisely this gap by focusing on upstream supply chains.

S Suraksha P · ETtech
Published On Mar 19, 2026 at 08:06 AM IST

Companies related to semiconductors have sought financial incentives, such as capital subsidies and rebates on power and taxes, to help achieve the stated goals of the second phase of the India Semiconductor Mission (ISM), underscoring the criticality of building a broader ecosystem beyond fabs.

Inox Air Products, for instance, sought a dedicated semiconductor materials localisation policy within the next six months.

"We don't see in the ISM 1.0 or SPECS scheme a very strong support for the semicon ecosystem players. The fab itself or the OSAT itself gets lots of incentives," said Diganta Kumar Sarma, head of strategy and business development at Inox Air Products.

Date	13th March
Publication	Economics Times
Link	https://economictimes.indiatimes.com/tech/technology/chip-firms-tap-gujarat-govt-for-free-trade-zone-and-shared-warehouse/articleshow/129518459.cms

THE ECONOMIC TIMES | tech
English Edition | Today's ePaper

ETPrime

Chip firms tap Gujarat govt for free trade zone and shared warehouse

By Suraksha P & Dia Rekhi, ETtech • Last Updated: Mar 13, 2026, 08:18:10 AM IST

Synopsis
Semiconductor equipment makers, memory storage suppliers and companies that specialise in chip packaging and testing have approached the Gujarat government, requesting setting up of an exclusive free trade zone and shared warehousing infrastructure for the sector, people in the know told ET.

Date	26th March
Publication	Money Control
Link	https://www.moneycontrol.com/news/business/helium-shock-puts-india-s-semiconductor-pcb-push-at-risk-due-to-the-iran-israel-war-13871222.html/amp

Helium shock puts India's semiconductor, PCB push at risk due to the Iran-Israel war

India's semiconductor chip and printed circuit board (PCB) industry is staring at a critical supply risk after Iran's March 19 strike on Qatar's Ras Laffan LNG hub disrupted a key global source of helium—an essential, non-substitutable input for chip fabrication.

The shock threatens to ripple through manufacturing lines just as India accelerates its ambitions of becoming a global electronics hub, exposing a key vulnerability in its supply chain.

Ashok Chandak, President of SEMI India and India Electronics and Semiconductor Association (IESA) separtely told Moneycontrol that most global semiconductor companies typically maintain 1–3 months of buffer stock, and in some cases even more. This provides a cushion against short-term supply disruptions.

That said, prices have firmed up—similar to what we've seen in oil markets. Helium prices have risen by about 30–50%. However, this does not significantly alter the cost of chips; the impact remains marginal for now.

"The real risk depends on how long the situation persists. If disruptions continue over an extended period, we could see pricing pressures and some tightening of supply. Over time, that could translate into chip shortages, which would then impact electronics production more broadly," Chandak said. "For now, though, the situation is not too concerning. It's a challenge, but a manageable one. Most large companies operate on long-term contracts rather than spot pricing, which insulates them from immediate volatility."

INDUSTRY STORY
ONLINE

Date	13th March
Publication	Economic Times

ETPrime

Chip firms tap Gujarat govt for free trade zone and shared warehouse

By Suraksha P & Dia Rekhi, ETtech • Last Updated: Mar 13, 2026, 08:18:10 AM IST

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Synopsis

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ET AI | Briefing

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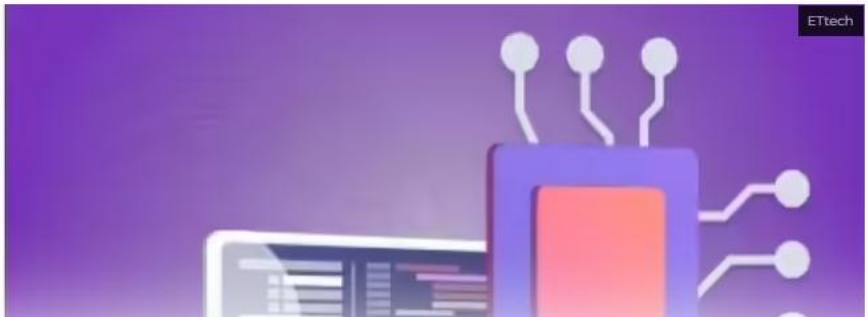

EXCLUSIVE INTERVIEW
PODCAST
ANI

Date	12th March
Publication	ANI

Pax Silica, Memory Chips & ISM 2.0: The Next Phase of India's Semiconductor Strategy | Ashok Chandak

INDUSTRY STORY
ONLINE

Date	12th March
Publication	Public Tv
Link	India to have capacity of 75-80 million chips per day through new semiconductor plants soon: IESA President - Public TV English

BUSINESS

India to have capacity of 75-80 million chips per day through new semiconductor plants soon: IESA President

By PUBLIC TV ENGLISH · SAVE IT
Last Updated: March 12, 2026 11:40 Am

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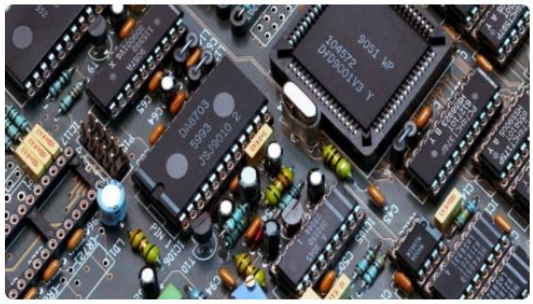

NEW DELHI: India's semiconductor ecosystem is expected to achieve a production capacity of 75-80 million chips per day as several newly announced semiconductor plants begin operations by the end of this year or early next year, according to Ashok Chandak, president of the India Electronics and Semiconductor Association (IESA) and SEMI India.

Chandak said that once all the announced semiconductor facilities become operational, India will see a significant boost in chip assembly and testing capacity. "So, totally all these companies put together, those who have announced the plants, in production by the end of the year, maybe early next year, depending on the schedule, we are looking at 75 to 80 million chips per day capacity, which is progressive," he said.

He added that this scale of production would mark a major milestone for the country's semiconductor sector. "Seventy-five to eighty million chips per day is a very big capacity. Some of it will get consumed in India, but a large part will be exported. By the end of the year, India's reputation and position worldwide in the semiconductor value chain will be very different," he said.

Date	12th March
Publication	ANI
Link	https://www.aninews.in/news/business/indias-semiconductor-journey-to-move-towards-design-led-manufacturing-for-worldwide-use-iesa-president-ashok-chandak20260312082432/

India's semiconductor journey to move towards design-led manufacturing for worldwide use: IESA President Ashok Chandak

ANI | Updated: Mar 12, 2026 08:24 IST

New Delhi [India], March 12 (ANI): India's semiconductor ecosystem is set to move towards design-led manufacturing, where chips are designed and manufactured within the country and then supplied globally, according to Ashok Chandak, President of the India Electronics and Semiconductor Association (IESA) and SEMI India.

In an exclusive conversation with ANI on India's progress in the semiconductor sector, Chandak said the country already has strong capabilities in chip design but now needs to ramp up manufacturing to complete the ecosystem.

"India is already good at design activity. We have to ramp up our manufacturing, and the next step will be design-led manufacturing. That means you design in India, and you manufacture in India and then use it worldwide," he said.

Chandak noted that various government policies have helped India move from aspiration to credibility in the global semiconductor industry.

"Based on the various policies and the progress which we have had till 2025, we have built trust. And now we are going to execute and scale up in 2026, '27, '28," he said.

He highlighted that several policy initiatives have contributed to the sector's development, including the India Semiconductor Mission (ISM), electronic policies, Production Linked Incentive, DLI (Design Linked Incentive), and Chips to Start-up (C2S) schemes. According to him, India is now recognised as a serious investable destination for electronics and semiconductors worldwide.

"As this ecosystem enters the critical phase of expansion and scale-up, we see this policy momentum continuing. In this year's Budget as well, additional allocation was provided for the electronic component systems scheme," Chandak said.

He further explained that ISM 1.0, launched in 2021, has now evolved into ISM 2.0 with an expanded scope.

"The ISM 1.0 became ISM 2.0, which has expanded its scope beyond fabs and foundries towards chemicals, gases, materials, and other areas. It is not limited to chip manufacturing alone but includes capabilities across design, tools, materials, and upstream segments," he said.

According to Chandak, around 10 plants have been approved under ISM 1.0, while another four to five projects have been approved by state governments.

"Things have really progressed a lot. We have now moved from a design-led capability to a manufacturing readiness, and the packaged chips are already available here, which is the first thing to start," he added.

Date	12th March
Publication	Time Of India
Link	https://timesofindia.indiatimes.com/auto/news/new-chip-plants-could-raise-indias-output-to-7580-million-per-day-iesa/amp_articleshow/129500285.cms

New chip plants could raise India's output to 75–80 million per day: IESA

Speaking to ANI, Chandak said the capacity would come from several semiconductor projects that are expected to start production in phases. Once these plants become operational, India's chip assembly and testing capabilities will expand significantly. "Together, the companies that have announced plants could bring capacity to around 75–80 million chips per day by the end of the year or early next year, depending on their timelines," he said.

Chandak said such output would represent a major step for the country's semiconductor industry. While some of the production will serve domestic demand, a significant portion is expected to be exported. He added that India's position in the global

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Date	12th March
Publication	Hindu Business Line
Link	https://www.thehindubusinessline.com/info-tech/india-shifts-towards-design-led-semiconductor-manufacturing-says-iesa-president/article70733664.ece/amp/

INFO-TECH

India shifts towards design-led semiconductor manufacturing, says IESA president

With strong design talent and policy support, country eyes global supply role through scaled-up production in coming years

By ANI

Updated - March 12, 2026 at 09:00 AM. | New Delhi

India's semiconductor ecosystem is set to move towards design-led manufacturing, where chips are designed and manufactured within the country and then supplied globally. This was stated by Ashok Chandak, President of the India Electronics and Semiconductor Association (IESA) and SEMI India.

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Date	12th March
Publication	The Tribune
Link	https://www.tribuneindia.com/news/business/india-to-have-capacity-of-75-80-million-chips-per-day-through-new-semiconductor-plants-soon-iesa-president/amp

India to have capacity of 75-80 million chips per day through new semiconductor plants soon: IESA President

ANI
Updated At : 08:40 AM Mar 12, 2026 IST

New Delhi [India], March 12 (ANI): India's semiconductor ecosystem is expected to achieve a production capacity of 75-80 million chips per day as several newly announced semiconductor plants begin operations by the end of this year or early next year, according to Ashok Chandak, President of the India Electronics and Semiconductor Association (IESA) and SEMI India.

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Date	12th March
Publication	Asia Net News
Link	https://newsable.asianetnews.com/business/ai-boom-drives-global-memory-chip-shortage-iesa-president-explains-articleshow-sl3g3uc

AI Boom Drives Global Memory Chip Shortage, IESA President Explains

3 Min read | Author : Asianet News Central | ANI
Published : Mar 12 2026, 11:00 AM IST

Ashok Chandak, President of the India Electronics and Semiconductor Association (IESA) (Photo-ANI)

The rapid rise in AI workloads is causing a global memory chip shortage. Companies are shifting production to advanced chips to meet AI demand, creating supply constraints and price hikes for other sectors like consumer electronics, says IESA's President.

AI Workloads Fuelling Memory Chip Shortage

The global shortage of memory chips is largely being driven by the rapid rise in artificial intelligence (AI) workloads, which has significantly increased demand for advanced memory solutions, according to Ashok Chandak, President of the India Electronics and Semiconductor Association (IESA) and SEMI India.

Speaking to ANI, Chandak said the strong demand for AI-related applications is pushing global semiconductor companies to prioritise the production of advanced memory chips. "My view is the memory chip shortage is mainly because of the increased demand for AI workloads. AI workloads require advanced memory chips, including HBM or high bandwidth memory chips," he said.

According to him, the surge in demand has strengthened pricing power for memory chip manufacturers, leading many global companies to shift production capacities toward these high-end chips. "Demand is very high and pricing power is strong. Many global companies are moving their capacities wherever possible towards these kinds of chips. It is a commercial decision," Chandak said.

Date	12th March
Publication	Economic Times CIO
Link	https://cio.economictimes.indiatimes.com/news/consumer-tech/india-set-to-produce-75-80-million-chips-daily-with-new-semiconductor-facilities/129489942

India to have capacity of 75-80 million chips per day through new semiconductor plants soon

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ANI

Published On Mar 12, 2026 at 08:55 AM IST

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Speaking to ANI, Chandak said that once all the announced semiconductor facilities become operational, India will see a significant boost in chip assembly and testing capacity.

Date	12th March
Publication	Business honours
Link	https://businesshonor.com/2026/03/india-semiconductor-sector-75-80-million-chips-capacity

India's Semiconductor Sector to Achieve 75-80 Million Chips per Da Capacity

Semiconductors and Electronics

Business Honor

New facilities to drive growth in assembly and testing, boosting exports and global reputation significantly soon nationwide.

India's semiconductor ecosystem is ready for a significant boost with the expected ramp up of production capacity to 75 to 80 million chips per day by the end of this year or early next year. According to Ashok Chandak, President of the India Electronics and Semiconductor Association (IESA) and SEMI India, several newly announced semiconductor plants are set to begin operations driving growth in chip assembly and quality testing capacity.

Once these facilities become operational India will see a substantial increase in its semiconductor output with a large part of the production expected to be exported. Chandak noted that this scale of production marks a major milestone for the country's semiconductor sector that has been focusing on assembly and testing of chips rather than wafer fabrication.

The recently inaugurated facility of Micron Technology in India is an example of an ATMP (Assembly, Test, Mark and Pack) plant, which is considered a smart packaging facility. Similar facilities being developed by companies such as Tata Electronics, Kaynes Technology, and CG Power and Industrial Solutions will operate as OSAT (Outsourced Semiconductor Assembly and Test) plants, performing the same task of assembling and testing semiconductor chips.

These plants will manufacture a range of chips including advanced DRAM, NAND and SSD (solid state drives), which are widely used across sectors such as AI, smartphones, laptops, and automotive. Chandak noted that the demand for memory chips has increased significantly due to the rise in AI workloads, and there is a shortage in the market. The chips assembled and tested in India will be used across multiple applications including AI workloads, automotive systems, laptops and smartphones.

Currently the chips being assembled and tested in India are likely to be in the 14 nanometer to 28 nanometer range while the wafer itself will continue to come from outside India. Chandak emphasized that by the end of the year, India's reputation and position worldwide in the semiconductor value chain will be very different with a significant boost in its semiconductor output and export capacity.

Date	12th March
Publication	Electronics for you
Link	https://www.electronicsforyou.biz/industry-buzz/india-targets-75-80-million-chips-per-day-capacity-as-new-semiconductor-plants-near-operations/

India Targets 75–80 Million Chips Per Day Capacity as New Semiconductor Plants Near Operations

India's semiconductor ecosystem is poised for a major boost in chip assembly and testing capacity

India is expected to reach a semiconductor production capacity of 75–80 million chips per day as several newly announced plants become operational by the end of this year or early next year, according to Ashok Chandak, President of the India Electronics and Semiconductor Association and SEMI India.

Speaking to a news portal, Chandak said that once the semiconductor facilities currently announced begin production, the country will witness a significant rise in chip assembly and testing capacity.

Date	12th March
Publication	English Public TV
Link	https://english.publictv.in/india-to-have-capacity-of-75-80-million-chips-per-day-through-new-semiconductor-plants-soon-iesa-president/

India to have capacity of 75-80 million chips per day through new semiconductor plants soon: IESA President

By PUBLIC TV ENGLISH • SAVE IT
Last Updated: March 12, 2026 11:40 Am

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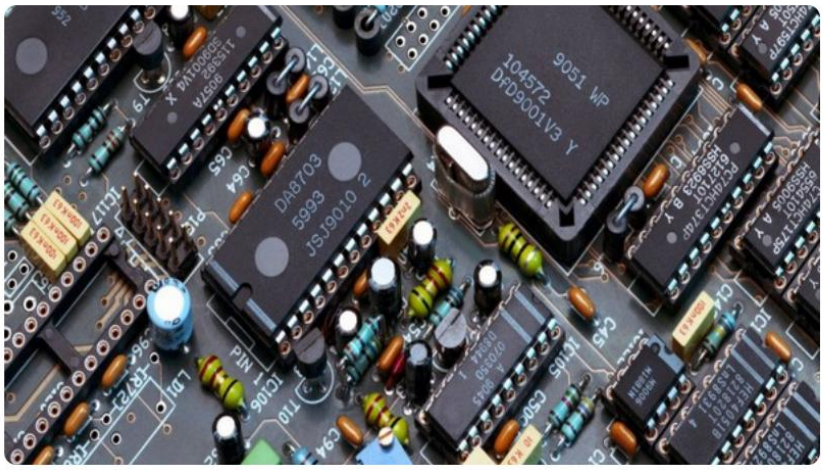

NEW DELHI: India's semiconductor ecosystem is expected to achieve a production capacity of 75-80 million chips per day as several newly announced semiconductor plants begin operations by the end of this year or early next year, according to Ashok Chandak, president of the India Electronics and Semiconductor Association (IESA) and SEMI India.

Chandak said that once all the announced semiconductor facilities become operational, India will see a significant boost in chip assembly and testing capacity. "So, totally all these companies put together, those who have announced the plants, in production by the end of the year, maybe early next year, depending on the schedule, we are looking at 75 to 80 million chips per day capacity, which is progressive," he said.

He added that this scale of production would mark a major milestone for the country's semiconductor sector. "Seventy-five to eighty million chips per day is a very big capacity. Some of it will get consumed in India, but a large part will be exported. By the end of the year, India's reputation and position worldwide in the semiconductor value chain will be very different," he said.

Date	12th March
Publication	Lokmat
Link	https://www.lokmattimes.com/business/indias-semiconductor-journey-to-move-towards-design-led-manufacturing-for-worldwide-use-iesa-president-ashok-chandak/

India's semiconductor journey to move towards design-led manufacturing for worldwide use: IESA President Ashok Chandak

New Delhi [India], March 12 : India's semiconductor ecosystem is set to move towards design-led manufacturing, where chips are designed and manufactured within the country and then supplied globally, according to Ashok Chandak, President of the India Electronics and Semiconductor Association (IESA) and SEMI India.

In an exclusive conversation withon India's progress in the semiconductor sector, Chandak said the country already has strong capabilities in chip design but now needs to ramp up manufacturing to complete the ecosystem.

Date	12th March
Publication	WebIndia 123
Link	https://news.webindia123.com/news/articles/Business/20260312/4426255.html

India to have capacity of 75-80 million chips per day through new semiconductor plants soon: IESA President

India's semiconductor ecosystem is expected to achieve a production capacity of 75-80 million chips per day as several newly announced semiconductor plants begin operations by the end of this year or early next year, according to Ashok Chandak, President of the India Electronics and Semiconductor Association (IESA) and SEMI India.

Speaking to ANI, Chandak said that once all the announced semiconductor facilities become operational, India will see a significant boost in chip assembly and testing capacity.

"So, totally all these companies put together, those who have announced the plants, in production by the end of the year, maybe early next year, depending on the schedule, we are looking at 75 to 80 million chips per day capacity, which is progressive," he said.

He added that this scale of production would mark a major milestone for the country's semiconductor sector.

Date	12th March
Publication	New Kerala
Link	https://www.newkerala.com/news/a/india-capacity-75-80-million-chips-per-day-through-485.htm

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India to Produce 75-80 Million Chips Daily as New Semiconductor Plants Ramp Up

India's semiconductor ecosystem is poised for a dramatic expansion, with newly announced plants expected to achieve a daily production capacity of 75-80 million chips by late this year or early next. This output will primarily focus on the assembly, testing, and packaging of chips, with facilities from companies like Micron, Tata Electronics, and Kaynes Technology leading the charge. The chips produced will cater to high-demand sectors including AI workloads, automotive systems, and consumer electronics. A significant portion of this production is slated for export, marking a major step in solidifying India's role in the global semiconductor value chain.

India's semiconductor ecosystem is expected to achieve a production capacity of 75-80 million chips per day as several newly announced semiconductor plants begin operations by the end of this year or early next year, according to Ashok Chandak, President of the India Electronics and Semiconductor Association and SEMI India.

Speaking to ANI, Chandak said that once all the announced semiconductor facilities become operational, India will see a significant boost in chip assembly and testing capacity.

"So, totally all these companies put together, those who have announced the plants, in production by the end of the year, maybe early next year, depending on the schedule, we are looking at 75 to 80 million chips per day capacity, which is progressive," he said.

He added that this scale of production would mark a major milestone for the country's semiconductor sector.

"Seventy-five to eighty million chips per day is a very big capacity. Some of it will get consumed in India, but a large part will be exported. By the end of the year, India's reputation and position worldwide in the semiconductor value chain will be very different," he said.

Date	12th March
Publication	Latestly
Link	https://www.latestly.com/agency-news/business-news-indias-semiconductor-journey-to-move-towards-design-led-manufacturing-for-worldwide-use-iesa-president-ashok-chandak-7350845.html/amp

Business News | India's Semiconductor Journey to Move Towards Design-led Manufacturing for Worldwide Use: IESA President Ashok Chandak

Get latest articles and stories on Business at LatestLY. India's semiconductor ecosystem is set to move towards design-led manufacturing, where chips are designed and manufactured within the country and then supplied globally, according to Ashok Chandak, President of the India Electronics and Semiconductor Association (IESA) and SEMI India.

Press Note 3 framework
Gujarat - Print

Date	13th March
Publication	Sabandh Bhart
Quote By	Ashok Chandak

અશોક ચાંડક, પ્રમુખ – ઈન્ડિયા ઈલેક્ટ્રોનિક્સ એન્ડ સેમિકન્ડક્ટર એસોસિએશન (IESA)

ફેમવર્ક હેઠળના રોકાણ સંબંધિત તાજેતરના નીતિ સુધારાઓ અંગે પ્રતિક્રિયા આપતાં **IESA**ના પ્રમુખ અશોક ચાંડકે જણાવ્યું કે આ પગલું ભારતના ઈલેક્ટ્રોનિક્સ મેન્યુફેક્ચરિંગ ઈકોસિસ્ટમને મજબૂત બનાવતા અને રાષ્ટ્રીય હિતોની સુરક્ષા કરતા સંતુલિત અને વ્યવહારુ નિર્ણય છે.

લાભકારી માલિકીની સ્પષ્ટતા અને ઝડપી મંજૂરી પ્રક્રિયા દ્વારા સરકારે વૈશ્વિક મૂડી અને ટેક્નોલોજી ભાગીદારીને અપસ્ટ્રીમ ઈલેક્ટ્રોનિક્સ મેન્યુફેક્ચરિંગ ક્ષેત્રમાં આકર્ષવા માટે અનુકૂળ વાતાવરણ ઉભું કર્યું છે.

તેમણે જણાવ્યું કે ભારતના ઈલેક્ટ્રોનિક્સ ક્ષેત્રના વિકાસ માટે હવે કમ્પોનેન્ટ્સ અને મટીરિયલ્સ ઈકોસિસ્ટમને મજબૂત બનાવવાની જરૂર છે, જે હાલમાં દેશની મેન્યુફેક્ચરિંગ વેલ્યુ ચેઈનમાં ખૂટતી કડી છે. **MLCC** કેપેસિટર, રેઝિસ્ટર, ઈન્ડક્ટર જેવા પેસિવ કમ્પોનેન્ટ્સ, કનેક્ટર્સ, ઈલેક્ટ્રોમેકેનિકલ કમ્પોનેન્ટ્સ, **PCB** ફેબ્રિકેશન અને મટીરિયલ્સ, તેમજ પોલિસિલિકોન અને સિલિકોન વેફર્સ જેવા સેમિકન્ડક્ટર સપ્લાય ચેઈન મટીરિયલ્સમાં રોકાણ આયાત પરની નિર્ભરતા ઘટાડવામાં અને સ્થાનિક ઉત્પાદન ક્ષમતાઓ વધારવામાં મહત્વપૂર્ણ સાબિત થઈ શકે છે.

આ સેગમેન્ટ્સ ઈલેક્ટ્રોનિક્સ ઉત્પાદનોના બિલ ઓફ મટીરિયલ્સનો લગભગ ૪૦ ટકા હિસ્સો ધરાવે છે. અશોક ચાંડકે વધુમાં જણાવ્યું કે ભારતમાં આ ક્ષેત્રોની માંગ પહેલેથી જ નોંધપાત્ર છે. પેસિવ કમ્પોનેન્ટ્સ માર્કેટનું કદ અંદાજે ૬ થી ૮ અબજ ડોલર, કનેક્ટર્સનું બજાર ૨ થી ૩ અબજ ડોલર અને ઁઝમ ઈકોસિસ્ટમ ૬ અબજ ડોલરથી વધુ છે. આમ હાલમાં કુલ ૧૫ થી ૧૮ અબજ ડોલરનું બજાર ઉપલબ્ધ છે, જે ભારતના ઈલેક્ટ્રોનિક્સ ઉત્પાદન વધતા ૨૦૩૦ સુધીમાં ૩૫ થી ૪૦ અબજ ડોલર સુધી પહોંચી શકે છે. આ ક્ષેત્રોમાં સ્થાનિક મેન્યુફેક્ચરિંગ વધવાથી દેશની અંદર વેલ્યુ એડિશન વધશે અને ભારતને વૈશ્વિક સપ્લાય ચેઈનમાં વધુ મજબૂત સ્થાન મળશે.

તેમણે ઉમેર્યું કે ઉદ્યોગ અને નીતિનિર્માતાઓએ ખાતરી કરવી જરૂરી છે કે આવા રોકાણો નોન-સ્ટ્રેટેજિક અને નોન-કન્ટ્રોલિંગ જ રહે. લાભકારી માલિકી, બોર્ડ પ્રતિનિધિત્વ અને ટેકનોલોજી ઍક્સેસ અંગે મજબૂત સુરક્ષા ઉપાયો હોવા જોઈએ. વૈશ્વિક મૂડી અને મેન્યુફેક્ચરિંગ ક્ષમતાનો લાભ લેવો મહત્વપૂર્ણ છે, પરંતુ કોઈ પણ બાહ્ય સંસ્થા ભારતના મહત્વપૂર્ણ ટેકનોલોજી ક્ષેત્રોમાં વ્યૂહાત્મક નિર્ણયોને પ્રભાવિત ન કરી શકે તેની ખાતરી કરવી જરૂરી છે.

અંતમાં અશોક ચાંડકે જણાવ્યું કે આ નીતિ સુધારાઓ સાથે ઈઝસ્જી યોજના જેવી પહેલો ભારતને મજબૂત સ્થાનિક ઈલેક્ટ્રોનિક્સ કમ્પોનેન્ટ્સ ઈકોસિસ્ટમ ઉભું કરવામાં મદદ કરશે અને દેશના ઈલેક્ટ્રોનિક્સ મેન્યુફેક્ચરિંગ ક્ષેત્રના આગામી વિકાસ તબક્કાને ગતિ આપશે

Date	13th March
Publication	Divya Gujarat
Quote By	Ashok Chandak

અશોક ચાંડક, પ્રમુખ – ઈન્ડિયા ઈલેક્ટ્રોનિક્સ એન્ડ સેમિકન્ડક્ટર એસોસિએશન (IESA)

ઉ ફ્રેમવર્ક હેઠળના રોકાણ સંબંધિત તાજેતરના નીતિ સુધારાઓ અંગે પ્રતિક્રિયા આપતાં IESAના પ્રમુખ અશોક ચાંડકે જણાવ્યું કે આ પગલું ભારતના ઈલેક્ટ્રોનિક્સ મેન્યુફેક્ચરિંગ ઈકોસિસ્ટમને મજબૂત બનાવતા અને રાષ્ટ્રીય હિતોની સુરક્ષા કરતા સંતુલિત અને વ્યવહારુ નિર્ણય છે. લાભકારી માલિકીની સ્પષ્ટતા અને ઝડપી મંજૂરી પ્રક્રિયા દ્વારા સરકારે વૈશ્વિક મૂડી અને ટેક્નોલોજી ભાગીદારીને અપસ્ટ્રીમ ઈલેક્ટ્રોનિક્સ મેન્યુફેક્ચરિંગ ક્ષેત્રમાં આકર્ષવા માટે અનુકૂળ વાતાવરણ ઉભું કર્યું છે. તેમણે જણાવ્યું કે ભારતના ઈલેક્ટ્રોનિક્સ ક્ષેત્રના વિકાસ માટે હવે કમ્પોનેન્ટ્સ અને મટીરિયલ્સ ઈકોસિસ્ટમને મજબૂત બનાવવાની જરૂર છે, જે હાલમાં દેશની મેન્યુફેક્ચરિંગ વેલ્યુ ચેઈનમાં ખૂટતી કડી છે. MLCC કેપેસિટર, રેઝિસ્ટર, ઈન્ડક્ટર જેવા પેસિવ કમ્પોનેન્ટ્સ, કનેક્ટર્સ, ઈલેક્ટ્રોમેકેનિકલ કમ્પોનેન્ટ્સ, PCB ફેબ્રિકેશન અને મટીરિયલ્સ, તેમજ પોલિસિલિકોન અને સિલિકોન વેફર્સ જેવા સેમિકન્ડક્ટર સપ્લાય ચેઈન મટીરિયલ્સમાં રોકાણ આયાત પરની નિર્ભરતા ઘટાડવામાં અને સ્થાનિક ઉત્પાદન ક્ષમતાઓ વધારવામાં મહત્વપૂર્ણ સાબિત થઈ શકે છે. આ સેગમેન્ટ્સ ઈલેક્ટ્રોનિક્સ ઉત્પાદનોના બિલ ઓફ મટીરિયલ્સનો લગભગ ૪૦ ટકા હિસ્સો ધરાવે છે.

Date	12th March
Publication	Rakhewal
Quote By	Ashok Chandak

રાષ્ટ્રીય રીતોની સુરક્ષા: અશોક ચાંડક, પ્રમુખ - ઈન્ડિયા ઈલેક્ટ્રોનિક્સ એન્ડ સેમિકન્ડક્ટર એસોસિએશન

પ્રેસ નોટ 3 ફ્રેમવર્ક હેઠળના રોકાણ સંબંધિત તાજેતરના નીતિ સુધારાઓ અંગે પ્રતિક્રિયા આપતાં IESAના પ્રમુખ અશોક ચાંડકે જણાવ્યું કે આ પગલું ભારતના ઈલેક્ટ્રોનિક્સ મેન્યુફેક્ચરિંગ ઈકોસિસ્ટમને મજબૂત બનાવતા અને રાષ્ટ્રીય હિતોની સુરક્ષા કરતા સંતુલિત અને વ્યવહારુ નિર્ણય છે. લાભકારી માલિકીની સ્પષ્ટતા અને ઝડપી મંજૂરી પ્રક્રિયા દ્વારા સરકારે વૈશ્વિક મૂડી અને ટેક્નોલોજી ભાગીદારીને અપસ્ટ્રીમ ઈલેક્ટ્રોનિક્સ મેન્યુફેક્ચરિંગ ક્ષેત્રમાં આકર્ષવા માટે અનુકૂળ વાતાવરણ ઉભું કર્યું છે.

તેમણે જણાવ્યું કે ભારતના ઈલેક્ટ્રોનિક્સ ક્ષેત્રના વિકાસ માટે હવે કમ્પોનેન્ટ્સ અને મટીરિયલ્સ ઈકોસિસ્ટમને મજબૂત બનાવવાની જરૂર છે, જે હાલમાં દેશની મેન્યુફેક્ચરિંગ વેલ્યુ ચેઈનમાં ખૂટતી કડી છે. MLCC કેપેસિટર, રેઝિસ્ટર, ઈન્ડક્ટર જેવા પેસિવ કમ્પોનેન્ટ્સ, કનેક્ટર્સ, ઈલેક્ટ્રોમેકેનિકલ કમ્પોનેન્ટ્સ, PCB ફેબ્રિકેશન અને મટીરિયલ્સ, તેમજ પોલિસિલિકોન અને સિલિકોન વેફર્સ જેવા સેમિકન્ડક્ટર સપ્લાય ચેઈન મટીરિયલ્સમાં રોકાણ આયાત પરની નિર્ભરતા ઘટાડવામાં અને સ્થાનિક ઉત્પાદન ક્ષમતાઓ વધારવામાં મહત્વપૂર્ણ સાબિત થઈ શકે છે. આ સેગમેન્ટ્સ ઈલેક્ટ્રોનિક્સ ઉત્પાદનોના બિલ ઓફ મટીરિયલ્સનો લગભગ 40 ટકા હિસ્સો ધરાવે છે.

અશોક ચાંડકે વધુમાં જણાવ્યું કે ભારતમાં આ ક્ષેત્રોની માંગ પહેલેથી જ નોંધપાત્ર છે. પેસિવ કમ્પોનેન્ટ્સ માર્કેટનું કદ અંદાજે 6 થી 8 અબજ ડોલર, કનેક્ટર્સનું બજાર 2 થી 3 અબજ ડોલર અને PCB ઈકોસિસ્ટમ 6 અબજ ડોલરથી વધુ છે. આમ હાલમાં કુલ 15 થી 18 અબજ ડોલરનું બજાર ઉપલબ્ધ છે, જે ભારતના ઈલેક્ટ્રોનિક્સ ઉત્પાદન વધતા 2030 સુધીમાં 35 થી 40 અબજ ડોલર સુધી પહોંચી શકે છે. આ ક્ષેત્રોમાં સ્થાનિક મેન્યુફેક્ચરિંગ વધવાથી દેશની અંદર વેલ્યુ એડિશન વધશે અને ભારતને વૈશ્વિક સપ્લાય ચેઈનમાં વધુ મજબૂત સ્થાન મળશે.

તેમણે ઉમેર્યું કે ઉદ્યોગ અને નીતિનિર્માતાઓએ ખાતરી કરવી જરૂરી છે કે આવા રોકાણો નોન-સ્ટ્રેટેજિક અને નોન-કન્ટ્રોલિંગ જ રહે. લાભકારી માલિકી, બોર્ડ પ્રતિનિધિત્વ અને ટેક્નોલોજી એક્સેસ અંગે મજબૂત સુરક્ષા ઉપાયો હોવા જોઈએ. વૈશ્વિક મૂડી અને મેન્યુફેક્ચરિંગ ક્ષમતાનો લાભ લેવો મહત્વપૂર્ણ છે, પરંતુ કોઈ પણ બાહ્ય સંસ્થા ભારતના મહત્વપૂર્ણ ટેક્નોલોજી ક્ષેત્રોમાં વ્યૂહાત્મક નિર્ણયોને પ્રભાવિત ન કરી શકે તેની ખાતરી કરવી જરૂરી છે.

Date	11th March
Publication	Gujarat Pranam
Quote By	Ashok Chandak

અશોક ચાંડક, પ્રમુખ – ઈન્ડિયા ઈલેક્ટ્રોનિક્સ એન્ડ સેમિકન્ડક્ટર એસોસિએશન (IESA)

પ્રેસ નોટ ૩ ફ્રેમવર્ક હેઠળના રોકાણ સંબંધિત તાજેતરના નીતિ સુધારાઓ અંગે પ્રતિક્રિયા આપતાં ઈજીઆઈના પ્રમુખ અશોક ચાંડકે જણાવ્યું કે આ પગલું ભારતના ઈલેક્ટ્રોનિક્સ મેન્યુફેક્ચરિંગ ઈકોસિસ્ટમને મજબૂત બનાવતા અને રાષ્ટ્રીય હિતોની સુરક્ષા કરતા સંતુલિત અને વ્યવહારુ નિર્ણય છે. લાભકારી માલિકીની સ્પષ્ટતા અને ઝડપી મંજૂરી પ્રક્રિયા દ્વારા સરકારે વૈશ્વિક મૂડી અને ટેક્નોલોજી ભાગીદારીને અપસ્ટ્રીમ ઈલેક્ટ્રોનિક્સ મેન્યુફેક્ચરિંગ ક્ષેત્રમાં આકર્ષવા માટે અનુકૂળ વાતાવરણ ઉભું કર્યું છે.

તેમણે જણાવ્યું કે ભારતના ઈલેક્ટ્રોનિક્સ ક્ષેત્રના વિકાસ માટે હવે કમ્પોનેન્ટ્સ અને મટીરિયલ્સ ઈકોસિસ્ટમને મજબૂત બનાવવાની જરૂર છે, જે હાલમાં દેશની મેન્યુફેક્ચરિંગ વેલ્યુ ચેઈનમાં ખૂટતી કડી છે. સ્ન્ઝઝ કેપેસિટર, રેઝિસ્ટર, ઈન્ડક્ટર જેવા પેસિવ કમ્પોનેન્ટ્સ, કનેક્ટર્સ, ઈલેક્ટ્રોમેકેનિકલ કમ્પોનેન્ટ્સ, ઁઝમ ફેબ્રિકેશન અને મટીરિયલ્સ, તેમજ પોલિસિલિકોન અને સિલિકોન વેફર્સ જેવા સેમિકન્ડક્ટર સપ્લાય ચેઈન મટીરિયલ્સમાં રોકાણ આયાત પરની નિર્ભરતા ઘટાડવામાં અને સ્થાનિક ઉત્પાદન ક્ષમતાઓ વધારવામાં મહત્વપૂર્ણ સાબિત થઈ શકે છે. આ સેગમેન્ટ્સ ઈલેક્ટ્રોનિક્સ ઉત્પાદનોના બિલ ઓફ મટીરિયલ્સનો લગભગ ૪૦ ટકા હિસ્સો ધરાવે છે.

ઈન્ડિગો, ભારતની પસંદગીની એ મુંબઈને જોડતી દૈનિક, સીધી

૦૫ માર્ચ ૨૦૨૬: ઈન્ડિગો, ભારતની પસંદગીની એરલાઈન, જામનગર અને નવી મુંબઈને જોડતી દૈનિક, સીધી ફ્લાઈટની જાહેરાત કરી છે, જે ૨૩ એપ્રિલ ૨૦૨૬ થી અમલમાં છે. આ વધારા સાથે, અમદાવાદ, વડોદરા, સુરત, રાજકોટ અને તાજેતરમાં જાહેર કરાયેલ ભાવનગર પછી જામનગર

Press Note 3 framework
Guwahati - Print

Date	13th March
Publication	The North East Times
Quote By	Ashok Chandak

'Recent policy refinements around investments a balanced step towards India's electronics manufacturing ecosystem'

By Ashok Chandak, President – India Electronics and Semiconductor Association (IESA)

"The recent policy refinements around investments under the Press Note 3 framework represent a balanced and pragmatic step towards strengthening India's electronics manufacturing ecosystem while safeguarding national interests. By providing clarity on beneficial ownership and introducing faster approval timelines, the government has created an enabling environment for attracting global capital and technology partnerships into upstream electronics manufacturing. India's electronics growth now requires strengthening the components and materials ecosystem, which is the missing layer in the country's manufacturing value chain. Investments in passive components such as MLCC capacitors, resistors and inductors, connectors and electromechanical components, PCB fabrication and materials, electronic capital goods, and semiconductor supply chain materials such as polysilicon and silicon wafers can significantly reduce import dependence and improve domestic manufacturing capabilities. These segments form the backbone of electronics manufacturing and account for nearly 40% of the bill of materials in electronic products, Said Ashok Chandak, President IESA.

India's current demand for these segments is already substantial — with the passive components market estimated at about $6–8 billion, connectors around $2–3 billion, and the PCB ecosystem exceeding $6 billion, creating a combined opportunity of $15–18 billion today and potentially $35–40 billion by 2030 as India's electronics production expands. Localizing manufacturing in these areas will increase domestic value addition, enable deeper integration into global supply chains, and support the rapid expansion of sectors such as mobile devices, consumer electronics, automotive electronics, telecom infrastructure, and industrial electronics, he continued.

At the same time, both industry and policymakers must exercise continued vigilance to ensure that investments remain non-strategic and non-controlling, with strong safeguards on beneficial ownership, board representation, and technology access. While India should actively leverage global capital and manufacturing capabilities, it is equally important that no external entity is able to influence strategic decision-making or exert undue pressure over India's critical technology sectors. Industry leaders must therefore approach partnerships with a long-term national perspective rather than being driven by short-term opportunities. Commented, Ashok Chandak, President IESA. Overall, the policy refinement, combined with initiatives such as the ECMS scheme, can help India build a strong domestic electronics components ecosystem and unlock the next phase of growth in the country's electronics manufacturing journey."

Date	13th March
Publication	The Meghalaya Guardian
Quote By	Ashok Chandak

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By Ashok Chandak, President – India Electronics and Semiconductor Association (IESA)

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Date	13th March
Publication	Sentinel
Quote By	Ashok Chandak

भारत के इलेक्ट्रॉनिक्स मैन्युफैक्चरिंग ईकोसिस्टम को मजबूत करने की दिशा में एक संतुलित और व्यावहारिक कदम : अशोक चांडक

मुंबई, 12 मार्च (एजेंसी)। प्रेस नोट 3 फ्रेमवर्क के तहत निवेश को लेकर हाल ही में नीति में किए गए सुधार, देश के हितों की सुरक्षा करते हुए भारत के इलेक्ट्रॉनिक्स मैन्युफैक्चरिंग ईकोसिस्टम को मजबूत करने की दिशा में एक संतुलित और व्यावहारिक कदम है। लाभकारी स्वामित्व पर स्पष्टता देकर और मंजूरी में तेजी लाकर, सरकार ने अपस्ट्रीम इलेक्ट्रॉनिक्स मैन्युफैक्चरिंग में वैश्विक पूंजी और तकनीकी साझेदारी को आकर्षित करने के लिए एक अच्छा माहौल बनाया है। एमएलसीसी कैपेसिटर, रेसिस्टर और इंडक्टर, कनेक्टर और इलेक्ट्रोमैकेनिकल कम्पोनेंट, पीसीबी फैब्रिकेशन और मटीरियल, इलेक्ट्रॉनिक कैपिटल गुड्स, और पॉलीसिलिकॉन और सिलिकॉन वेफर्स जैसे सेमीकंडक्टर सप्लाई चेन मटीरियल जैसे पैसिव कम्पोनेंट्स में निवेश से आयात पर निर्भरता काफी कम हो सकती है और घरेलू मैन्युफैक्चरिंग क्षमताओं में सुधार हो सकता है। आईईएसए के प्रेसिडेंट अशोक चांडक ने कहा कि ये सेगमेंट इलेक्ट्रॉनिक्स मैन्युफैक्चरिंग की रीढ हैं और इलेक्ट्रॉनिक प्रोडक्ट्स में 'बिल ऑफ मटीरियल' का लगभग 40 प्रतिशत हिस्सा हैं। भारत में इन सैगमेंट की मौजूदा मांग पहले से ही काफी ज्यादा है-पैसिव कम्पोनेंट्स का बाजार लगभग 6-8 अरब डॉलर का है, कनेक्टर बाजार लगभग 2-3 अरब डॉलर का है और पीसीबी ईकोसिस्टम 6 अरब डॉलर से ज्यादा का है, जिससे आज कुल मिलाकर 15-18 अरब डॉलर का अवसर बन रहा है और 2030 तक भारत का इलेक्ट्रॉनिक्स प्रोडक्शन बढने पर यह 35-40 अरब डॉलर हो सकता है। उन्होंने आगे कहा कि इन क्षेत्रों में मैन्युफैक्चरिंग का स्थानीयकरण करने से घरेलू मूल्य संवर्धन बढेगा, वैश्विक आपूर्ति श्रृंखला में गहराई से एकीकरण हो पाएगा, तथा मोबाइल डिवाइस, कंज्यूमर इलेक्ट्रॉनिक्स, ऑटोमोटिव इलेक्ट्रॉनिक्स, टेलीकॉम इंफ्रास्ट्रक्चर और इंडस्ट्रियल इलेक्ट्रॉनिक्स जैसे सेक्टरों के तेजी से बढने में मदद मिलेगी। इसके साथ ही, उद्योग जगत और नीति निर्माताओं, दोनों को निरंतर निगाह रखनी चाहिए।

Date	13th March
Publication	Gana Adhikar
Quote By	Ashok Chandak

ভাৰতৰ ইলেক্ট্ৰনিক্স উৎপাদন ব্যৱস্থা মজবুত কৰাৰ পদক্ষেপ

গুৱাহাটী, ১৬ মাৰ্চ ঃ ফ্রেমৱৰ্ক অধীনত বিনিয়োগৰ ক্ষেত্রত শেহতীয়া নীতি সংশোধনসমূহে ভাৰতৰ ইলে"নি' উৎপাদন ব্যৱস্থা মজবুত কৰাৰ দিশত এক সন্তুলিত আৰু বাস্তৱবাদী পদক্ষেপৰ প্রতিনিধিত্ব কৰে, একে সময়তে ৰাষ্ট্রীয় স্বার্থ ৰক্ষা কৰি। লাভজনক মালিকীস্বত্ব সম্পর্কে স্পষ্টতা প্রদান কৰি আৰু অনুমোদনৰ সময়সীমা দ্রুত কৰি, চৰকাৰে ঊৰ্ধ্বগামী ইলেকট্রনিক্স উৎপাদন ক্ষেত্রলৈ বৈশ্বিক মূলধন আৰু প্রযুক্তিগত অংশীদাৰিত্ব আকর্ষণ কৰাৰ বাবে এক সহায়ক পৰিৱেশ সৃষ্টি কৰিছে।ইণ্ডিয়া ইলে"নি' এণ্ড ছেমিকণ্ডাক্টৰ এছ'চিয়েচন-ৰ সভাপতি অশোক চন্দকে কয় যে ভাৰতৰ ইলে"নি'ৰ বৃদ্ধিৰ বাবে এতিয়া উপাদান আৰু সামগ্রীৰ ব্যৱস্থা মজবুত কৰাৰ প্রয়োজন, যিটো-দেশৰ উৎপাদন মূল্য শৃংখলাত অনুপস্থিত স্তৰ। নিষ্ক্রিয় উপাদান যেনে এমএলচিচি কেপাচিটৰ, ৰেজিষ্টৰ আৰু ইণ্ডাক্টৰ, কানেক্টৰ আৰু ইলেকট্র'মেকানিকেল উপাদান, পিচিবি ফেব্রিকেচন আৰু সামগ্রী, ইলেক্ট্রনিক কেপিটেল গুডছ, আৰু ছেমিকণ্ডাক্টৰ যোগান শৃংখলাৰ সামগ্রী যেনে পলিচিলিকন আৰু চিলিকন ৱেফাৰত বিনিয়োগে আমদানি নির্ভৰশীলতা যথেষ্ট হ্রাস কৰিব পাৰে আৰু দেশীয় উৎপাদন ক্ষমতা উন্নত কৰিব পাৰে।

Date	13th March
Publication	Dainik Purvoday
Quote By	Ashok Chandak

निवेश को लेकर नीति में किए गए सुधार देश के हित में :चांडक

नई दिल्ली, 16 मार्च (एजेंसी)। इंडिया इलेक्ट्रॉनिक्स एंड सेमीकंडक्टर एसोसिएशन (आईईएसए) के प्रेसिडेंट अशोक चांडक ने निवेश को लेकर हाल ही में नीति में किए गए सुधार को देश के हितों की सुरक्षा करने वाला तथा इलेक्ट्रॉनिक्स मैन्युफैक्चरिंग ईकोसिस्टम को मजबूत करने की दिशा में एक संतुलित और व्यावहारिक कदम बताया है। लाभकारी स्वामित्व पर स्पष्टता देकर और मंजूरी में तेजी लाकर सरकार ने अपस्ट्रीम इलेक्ट्रॉनिक्स मैन्युफैक्चरिंग में वैश्विक पूंजी और तकनीकी साझेदारी को आकर्षित करने के लिए एक अच्छा माहौल बनाया है।

भारत की इलेक्ट्रॉनिक्स वृद्धि के लिए अब कम्पोनेंट्स और मटीरियल ईकोसिस्टम को मजबूत करने की जरूरत है, क्योंकि यही वो परत है तो हमारे देश की मैन्युफैक्चरिंग वैल्यू चेन में नहीं है।

एमएलसीसी कैपेसिटर, रेसिस्टर और इंडक्टर, कनेक्टर और इलेक्ट्रोमैकेनिकल कम्पोनेंट, पीसीबी फैब्रिकेशन और मटीरियल, इलेक्ट्रॉनिक कैपिटल गुड्स, और पॉलीसिलिकॉन और सिलिकॉन वेफर्स जैसे सेमीकंडक्टर सप्लाई चेन मटीरियल जैसे पैसिव कम्पोनेंट्स में निवेश से आयात पर निर्भरता काफी कम हो सकती है और घरेलू मैन्युफैक्चरिंग क्षमताओं में सुधार हो सकता है। श्री चांडक ने कहा कि ये सेगमेंट इलेक्ट्रॉनिक्स मैन्युफैक्चरिंग की रीढ़ हैं और इलेक्ट्रॉनिक प्रोडक्ट्स में 'बिल ऑफ मटीरियल' का लगभग 40 प्रतिशत हिस्सा है।

Date	12th March
Publication	Purvanchal Prahari
Quote By	Ashok Chandak

फ्रेमवर्क के तहत निवेश को लेकर हाल ही में नीति में किए गए सुधार

गुवाहाटी : फ्रेमवर्क के तहत निवेश को लेकर हाल ही में नीति में किए गए सुधार, देश के हितों की सुरक्षा करते हुए भारत के इलेक्ट्रॉनिक्स मैन्युफैक्चरिंग ईकोसिस्टम को मजबूत करने की दिशा में एक संतुलित और व्यावहारिक कदम है। लाभकारी स्वामित्व पर स्पष्टता देकर और मंजूरी में तेजी लाकर, सरकार ने अपस्ट्रीम इलेक्ट्रॉनिक्स मैन्युफैक्चरिंग में वैश्विक पूंजी और तकनीकी साझेदारी को आकर्षित करने के लिए एक अच्छा माहौल बनाया है। भारत की इलेक्ट्रॉनिक्स वृद्धि के लिए अब कम्पोनेंट्स और मटीरियल ईकोसिस्टम को मजबूत करने की जरूरत है, क्योंकि यही वो परत है तो हमारे देश की मैन्युफैक्चरिंग वैल्यू चेन में नहीं है। एमएलसीसी कैपेसिटर, रेसिस्टर और इंडक्टर, कनेक्टर और इलेक्ट्रोमैकेनिकल कम्पोनेंट, पीसीबी फैब्रिकेशन और मटीरियल, इलेक्ट्रॉनिक कैपिटल गुड्स और पॉलीसिलिकॉन और सिलिकॉन वेफर्स जैसे सेमीकंडक्टर सप्लाई चेन मटीरियल जैसे पैसिव कम्पोनेंट्स में निवेश से आयात पर निर्भरता काफी कम हो सकती है और घरेलू मैन्युफैक्चरिंग क्षमताओं में सुधार हो सकता है।

Press Note 3 framework
National - Print

Date	12th March
Publication	Financial Express
Quote By	Ashok Chandak

PRESS NOTE 3 EASING EXPECTED TO UNLOCK TECHNOLOGY TIE-UPS

Push to electronics manufacturing

URVI MALVANIA
Mumbai, March 11

THE EASING OF investment restrictions under Press Note 3 is expected to give a fresh push to India's electronics manufacturing ambitions by enabling faster technology tie-ups and minority investments in component manufacturing.

Industry executives and analysts told Fe that the changes could complement the recently launched electronics components manufacturing scheme (ECMS), which aims to deepen domestic production of components and materials used in electronic devices. The scheme has an outlay of ₹40,000 crore and targets segments such as passive components, printed circuit boards and semiconductor supply chain materials.

Industry executives said the new PN 3 framework could ease collaborations between Indian manufacturers and global technology providers, particularly in upstream electronics manufacturing.

VOCAL FOR LOCAL

- The scheme has an outlay of **₹40,000 cr**
- It targets segments such as passive components, printed circuit boards and semiconductor supply chain materials

- Easing of rules signals a stronger policy focus on building a domestic component ecosystem, say analysts
- India still depends heavily on imports for key components

Ashok Chandak, president of the India Electronics and Semiconductor Association, said the move brings greater clarity for investors. "Clear rules on beneficial ownership and faster approvals will help attract technology partnerships into electronics manufacturing," he said.

India has expanded electronics assembly rapidly over the past few years, driven by incentives such as the production-linked incentive scheme. However, the country still depends heavily on imports for key components.

Analysts said the easing of investment rules alongside the ECMS signals a stronger policy focus on building a domestic component ecosystem. "India has virtually no background in electronic components manufacturing. Foreign support will be key," analysts at JM Financial said, adding that faster approvals would help ensure that projects under the component manufacturing scheme move quickly.

Several investment proposals in the electronics ecosystem are awaiting approvals under PN 3. Among the most closely watched is a proposed joint venture between Dixon Technologies and smartphone maker Vivo, which has been under regulatory review.

Industry executives said similar partnerships could emerge in areas such as display modules, printed circuit boards, connectors and passive components as companies look to localise supply chains.

Over the past few years, regulatory changes have already pushed smartphone brands to rely more on Indian manufacturing partners. Chinese companies like Xiaomi have tied up with local manufacturers including Dixon Technologies and Optiemus for assembly and exports, while other handset makers have adopted similar models.

The latest policy tweak could accelerate this shift by making it easier for companies to bring in technology and minority capital for component production while retaining majority ownership with Indian entities.

Industry estimates suggest the domestic market for passive components, connectors and printed circuit boards is already worth over $15 billion and could expand significantly as electronics production scales up in India. Strengthening the component base is seen as critical to reducing import dependence and improving the competitiveness of the electronics manufacturing sector.

Date	12th March
Publication	The Times Of India
Quote By	Ashok Chandak

FDI rejig: Global investors with small Chinese stake likely to gain

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Chennai/ New Delhi: The changes in foreign direct investment (FDI) rules for China and other land bordering countries (LBCs) are expected to fast track investment by global investment firms, such as Blackrock and Carlyle, as they were feeling the heat of approvals required, even if there was a very small Chinese shareholding.

On Wednesday, the Union cabinet allowed for tweaks in Press Note 3, which in 2020 had kept all FDIs from China, Hong Kong and other LBCs out of the automatic route. Now, companies can get automatic approval for investment in India, where beneficial ownership of Chinese entities are under 10% and they do not exercise control.

"We are opening up in a strategic and calibrated manner... It's a changing world and the opening up doesn't mean that concerns with regards to security have gone away," Amardeep Singh Bhatia, secretary for department of promotion of industry and internal trade, told reporters.

He said that a detailed SOP, along with a list of product categories for faster approvals in strategic sectors will be released "as soon as possible". For sectors such as capital goods, electronic capital goods, electronic components, polysilicon and ingot-wafer, proposals will be cleared within 60 days, while ensuring that majority shareholding and control remains with resident Indian citizens or entities controlled by them. Rare earth and rare earth magnets are expected to be among the list of productions that will be notified by DPIIT.

"In the expedited process, some steps have been done away with... but broadly, as far as the security clearances are required, political clearance is required, that process will remain in place," Bhatia said.

Easing of rules are expected to remove regulatory uncertainties that had stalled Indian joint ventures with Chinese partners since 2020, although it is not going to be easy for the Chinese majors, including BYD, to enter the market. With this, Indian companies are expected to easily access capital and process technologies, which are crucial for building a domestic ecosystem, as China currently dominates the global electronic manufacturing landscape.

J S Gujral, MD of Syrma SGS, an electronics manufacturing services provider to global players, said: "Easing rules will enable technology partnership and bridge certain gaps in the domestic availability of components, specialised materials and advanced manufacturing know-how."

The investments are likely to come in electronic components, such as passive devices, connectors, PCB manufacturing, and electronic capital goods, where India has large demand but limited domestic manufacturing capacity, said Ashok Chandak, president of IESA. The move is also expected to help India in electronics capital goods, including SMT assembly lines, chip materials, such as Polysilicon and silicon ingots and even assembly materials, such as enclosures and mechanical parts.

Shardul S Shroff, executive chairman of Shardul Amarchand Mangaldas said an expedited approval timeline for investments will bring greater certainty in processing timelines but will have limited applicability due to stringent requirements. Some experts said to make this meaningful BIS reforms are needed, including faster approval timelines, simplification and expanding testing infrastructure.

FAST-TRACKING CLEARANCES

- For sectors such as capital goods, electronic components, polysilicon and ingot-wafer, proposals will be cleared within 60 days
- Rare earth and rare earth magnets are expected to be on the list of department of promotion of industry and internal trade (DPIIT)
- Investments are likely to come in electronic components, such as passive devices, connectors, PCB manufacturing and electronic capital goods

> Opening up doesn't mean that concerns with regards to security have gone away
>
> —AMARDEEP SINGH BHATIA | SECRETARY, DPIIT

Date	12th March
Publication	The Telegraph
Quote By	Ashok Chandak

Gates reopen for Chinese capital

OUR SPECIAL CORRESPONDENT

Calcutta: The Centre's decision to ease foreign direct investment (FDI) rules for investors linked to countries sharing land borders with India is expected to reopen limited avenues for Chinese capital and help accelerate the clearance of pending investment proposals. However, strict ownership caps mean large investments will continue to be subject to government scrutiny.

The Union Cabinet on Tuesday introduced amendments to Press Note 3, including a formal definition of beneficial ownership. The changes allow investments to proceed through the automatic route if investors from land-bordering countries (LBC) hold up to 10 per cent non-controlling ownership in the investing entity.

The government has also introduced an expedited approval process with a 60-day timeline for specified manufacturing sectors, including capital goods, electronic capital goods, electronic components, polysilicon, and ingot-wafer.

Financial sector analysts on Wednesday said that under the press note 3, which was introduced in 2020, investments from countries that share a land border with India required government approval. As a result, there was a pileup of about 600 applications, and the Centre had to take steps to ease the process, especially in certain sectors such as electronic capital goods and components.

BIZ BOOM

- The pending applications under the 10% threshold will go through the automatic route once the notification is issued
- For the specified sectors, a mechanism is being laid down for expedited approvals to ensure the 60-day timeline is followed

DPIIT secretary Amardeep Singh Bhatia said that the pending applications covered under the 10 per cent threshold will go through the automatic route once the notification is issued, while for the specified sectors, a mechanism is being laid down for expedited approvals to ensure the 60-day timeline is followed.

Bhatia also said that the list of specified sectors can be expanded or reduced by a committee of secretaries headed by the cabinet secretary.

"All the restrictions for investors from LBCs are still applicable. This relaxation is only for entities in non-LBCs and having beneficial owners from LBCs below 10 per cent and non-controlling stake," said Jai Prakash Shivahare, joint secretary in the department for promotion of industry and internal trade (DPIIT).

Electronics boost

The policy change comes soon after the Union Budget expanded the outlay for the Electronics Components Manufacturing Scheme (ECMS) to ₹40,000 crore from ₹22,919 crore, signalling a stronger policy push to deepen domestic electronics manufacturing.

"Pursuant to the announcement, the government has amended the FDI policy for countries sharing land borders with India. This will promote ease of doing business in India and facilitate greater foreign investments in India, particularly in the manufacturing sector. With this, pending investments/business plans can now be activated," said Prashant Bhojwani, partner, corporate tax, tax & regulatory advisory at BDO India.

Industry representatives said the changes could help accelerate technology partnerships and supply chain integration.

"This reform will help companies move faster in forming technology partnerships, expanding manufacturing in India and integrating with global value chains," said Pankaj Mohindroo, chairman of the India Cellular and Electronics Association.

Ashok Chandak, president of the India Electronics and Semiconductor Association, said the provision allowing non-strategic and non-controlling investments up to defined thresholds under the automatic route would help facilitate global fund participation while retaining appropriate oversight.

The country's electronics production has grown from ₹1.9 lakh crore in 2014–15 to ₹11.3 lakh crore in 2024–25, while exports rose from ₹38,000 crore to ₹3.27 lakh crore in the same period.

Date	12th March
Publication	The Hindu
Quote By	Ashok Chandak

EASED INVESTMENTS

'Changes in FDI rules to aid rare earth sector'

BUSINESS » PAGE 15

Date	12th March
Publication	Hindustan Times
Quote By	Ashok Chandak

Cabinet eases investment rules for China, neighbours

Rajeev Jayaswal
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NEW DELHI: Six years after India restricted investments from companies based in China and other countries that share a land border with it in local entities, the Union cabinet on Tuesday allowed the same conditionally, to boost specific sectors (such as electronic components and capital goods manufacturing) and attract more foreign direct investment in start-ups, especially in emerging deep tech areas.

"The Union Cabinet chaired by Prime Minister Shri Narendra Modi has approved change in guidelines on investments from countries sharing land border with India (LBCs)," said a government statement issued after the cabinet meeting.

The changes are measured and calibrated as detailed by the statement: the investments cannot exceed 10% beneficial ownership, but will be allowed automatically, albeit with applicable sectoral caps and other rules; and the investee entity has to report relevant information to DPIIT. DPIIT or the department for promotion of industry and internal trade (DPIIT) is an arm of commerce and industry ministry.

The new policy provides for time-bound expedited clearance -- within 60 days -- of investments in specific sectors, manufacturing of capital goods, electronic components, and polysilicon and ingot-wafers.

"CoS [committee of secretaries] under the Cabinet Secretary may also revise the list of specified sectors," the statement added. "... the majority shareholding and control of the investee entity will be with resident Indian citizen(s) and/or resident Indian entity(ies) owned and controlled by resident Indian citizen(s), at all times,"the statement added.

The changes were made after

continued on →11

Press Note 3 framework
National - Online

Date	11th March
Publication	Hindustan Times
Link	https://www.hindustantimes.com/india-news/cabinet-eases-investment-rules-for-china-and-neighbours-sharing-land-borders-with-india-101773188475787.html

Cabinet eases investment rules for China and neighbours sharing land borders with India

The changes were made after Centre realised that restricting non-strategic, non-controlling interests could be adversely affecting investment flows.

Updated on: Mar 11, 2026 8:05 AM IST

By Rajeev Jayaswal

The new policy provides for time-bound expedited clearance -- within 60 days -- of investments in specific sectors, manufacturing of capital goods, electronic components, and polysilicon and ingot-wafers. (PTI)

Six years after India restricted investments from companies based in China and other countries that share a land border with it in local entities, the Union cabinet on Tuesday allowed the same conditionally, to boost specific sectors (such as electronic components and capital goods manufacturing) and attract more foreign direct investment in start-ups, especially in emerging deep tech areas.

Date	11th March
Publication	The Telegraph
Link	https://www.telegraphindia.com/business/india-eases-fdi-rules-for-border-countries-with-10-per-cent-cap-under-press-note-3-changes-prnt/cid/2150903#goog_rewarded

India eases FDI rules under Press Note 3 with 10 per cent cap for border country investors

New policy defines beneficial ownership and fast tracks approvals in key manufacturing sectors as government seeks to clear hundreds of pending investment proposals

Our Special Correspondent | Published 12.03.26, 04:57 AM

Representational picture

The Centre's decision to ease foreign direct investment (FDI) rules for investors linked to countries sharing land borders with India is expected to reopen limited avenues for Chinese capital and help accelerate the clearance of pending investment proposals. However, strict ownership caps mean large investments will continue to be subject to government scrutiny.

The Union Cabinet on Tuesday introduced amendments to Press Note 3, including a formal definition of beneficial ownership. The changes allow investments to proceed through the automatic route if investors from land-bordering countries (LBC) hold up to 10 per cent non-controlling ownership in the investing entity.

Date	11th March
Publication	Financial Express
Link	https://www.financialexpress.com/business/news/pn3-easing-may-speed-electronics-component-manufacturing/4169961/

PN3 easing may speed electronics component manufacturing

Move expected to unlock technology tie-ups and pending proposals in the supply chain

Written by **Urvi Malvania**

March 12, 2026 00:34 IST

FDI Policy Shift: Eased Press Note 3 Rules Set to Supercharge India's Electronics Component Ecosystem

The easing of investment restrictions under Press Note 3 is expected to give a fresh push to India's electronics manufacturing ambitions by enabling faster technology tie-ups and minority investments in component manufacturing.

Bridging the Component Gap

Industry executives and analysts told Fe that the changes could complement the recently launched electronics components manufacturing scheme (ECMS), which aims to deepen domestic production of components and materials used in electronic devices. The scheme has an outlay of Rs 40,000 crore and targets segments such as passive components, printed circuit boards and semiconductor supply chain materials.

Industry executives said the new PN 3 framework could ease collaborations between Indian manufacturers and global technology providers, particularly in upstream electronics manufacturing.

Ashok Chandak, president of the India Electronics and Semiconductor Association, said the move brings greater clarity for investors. "Clear rules on beneficial ownership and faster approvals will help attract technology partnerships into electronics manufacturing," he said.

Date	11th March
Publication	Times Of India
Link	https://timesofindia.indiatimes.com/business/india-business/fdi-rejig-global-investors-with-small-chinese-stake-likely-to-gain/articleshow/129487629.cms

FDI rejig: Global investors with small Chinese stake likely to gain

Vaitheeswaran B / TNN / Mar 12, 2026, 07:20 IST

CHENNAI/ NEW DELHI: The changes in foreign direct investment (FDI) rules for China and other land bordering countries (LBCs) are expected to fast track investment by global investment firms, such as Blackrock and Carlyle, as they were feeling the heat of approvals required, even if there was a very small Chinese shareholding.

On Wednesday, the Union cabinet allowed for tweaks in Press Note 3, which in 2020 had kept all FDIs from China, Hong Kong and other LBCs out of the automatic route. Now, companies can get automatic approval for investment in India, where beneficial ownership of Chinese entities are under 10% and they do not exercise control.

"We are opening up in a strategic and calibrated manner... It's a changing world and the opening up doesn't mean that concerns with regards to security have gone away," Amardeep Singh Bhatia, secretary for department of promotion of industry and internal trade, told reporters.

Israel Iran War

- US-Israel-Iran War News Live Updates: Blasts reported near Pakistan embassy in Tehran as Israel launches fresh wave of strikes
- Did CIA tell Donald Trump Iran's supreme leader Mojtaba Khamenei is gay? What US President claimed
- Trump Extends Iran Strike Pause: US President ties 10-day delay to eight tankers; talks are ongoing

He said that a detailed SOP, along with a list of product categories for faster approvals in strategic sectors will be released "as soon as possible". For sectors such as capital goods, electronic capital goods, electronic components, polysilicon and ingot-wafer, proposals will be cleared within 60 days, while ensuring that majority shareholding and control remains with resident Indian citizens or entities controlled by them.

Date	11th March
Publication	Daily Hunt
Link	https://m.dailyhunt.in/news/india/english/the+telegraph-epaper-thtlgrph/india+eases+fdi+rules+under+press+note+3+with+10+per+cent+cap+for+border+country+investors-newsid-n704192328

India eases FDI rules under Press Note 3 with 10 per cent cap for border country investors

The Telegraph Online 2 weeks ago

The Centre's decision to ease foreign direct investment (FDI) rules for investors linked to countries sharing land borders with India is expected to reopen limited avenues for Chinese capital and help accelerate the clearance of pending investment proposals.

However, strict ownership caps mean large investments will continue to be subject to government scrutiny.

The Union Cabinet on Tuesday introduced amendments to Press Note 3, including a formal definition of beneficial ownership. The changes allow investments to proceed through the automatic route if investors from land-bordering countries (LBC) hold up to 10 per cent non-controlling ownership in the investing entity.

Date	11th March
Publication	Money Control
Link	https://www.moneycontrol.com/technology/press-note-3-tweak-60-day-fdi-nod-timeline-to-aid-electronics-components-ecosystem-industry-article-13856502.html

Press Note 3 tweak, 60-day FDI nod timeline to aid electronics components ecosystem: Industry

IESA says clearer rules could accelerate investments in passive components, PCBs and upstream semiconductor materials as firms explore China+1 shift

AIHIK SUR | MARCH 11, 2026 / 08:37 IST

The Union Cabinet on March 10 approved tweaks to the Press Note 3

AI Powered Summary

- Union Cabinet eases FDI approvals with a 60-day timeline.
- Move expected to boost electronics and semiconductor investments.
- New rules target quicker tech partnerships, global supply chain integration.

Did our AI summary help?

Read AI shorts

Industry stakeholders have welcomed the Union Cabinet's decision to ease foreign direct investment (FDI) approvals and introduce a defined 60-day timeline, saying the move could invite fresh capital and joint ventures in India's electronics and semiconductor ecosystem.

Ashok Chandak, president of the India Electronics and Semiconductor Association (IESA), said the relaxation of norms under Press Note 3 would make it easier for global investors to participate in the industry.

"The clarification on beneficial ownership and calibrated relaxation under PN3 will help unlock global venture and private equity investments into startups, deep-tech companies and manufacturing ventures, while enabling faster technology partnerships and stronger integration with global supply chains," Chandak said.

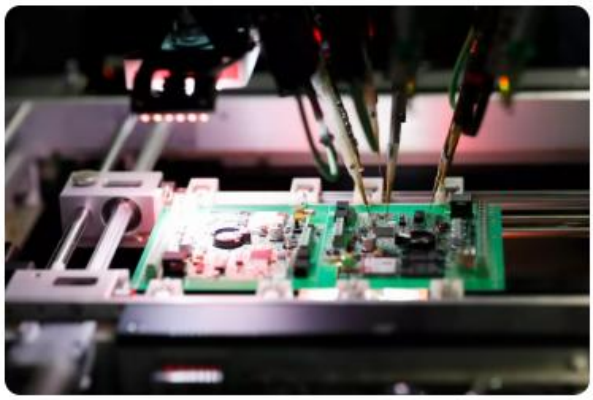
He said the impact could be particularly significant in segments where India still relies heavily on imports.

Date	11th March
Publication	ET Telecom
Link	https://telecom.economictimes.indiatimes.com/news/devices/indias-new-fdi-rules-boosting-tech-joint-ventures-with-caution-in-strategic-sectors/129441683

'India's fresh FDI rules to expedite tech JV formations; caution needed in critical sectors'

Under the relaxed Press Note 3 rules cleared by the cabinet on Tuesday, investments from entities with less than 10% non-controlling beneficial ownership in border countries will be permitted through the automatic route, subject to the applicable sectoral cap, according to a government statement.

ETTelecom Desk • ETTelecom
Updated On Mar 12, 2026 at 12:04 PM IST



NEW DELHI: The Centre's decision to relax rules on foreign direct investment (FDI) from countries that share a land border with India is expected to attract capital into critical sectors such as electronics and wafer manufacturing, and also expedite the formation of technology partnerships, according to industry associations.

The long-awaited move is expected to pave the way for FDI from China and bolster India's manufacturing push.

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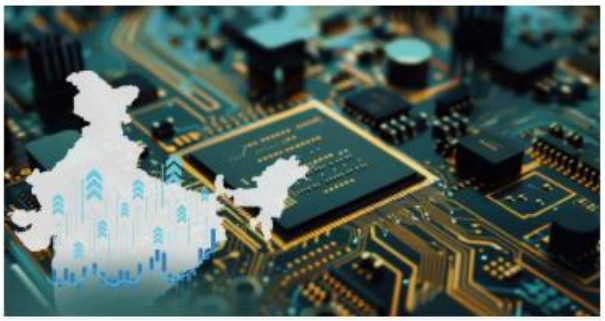
Date	11th March
Publication	Data Quest
Link	https://www.dqindia.com/esdm/government-push-to-boost-electronics-components-manufacturing-to-strengthen-indias-semiconductor-ecosystem-11194047

Government push to boost electronics components manufacturing to strengthen India's semiconductor ecosystem

The policy refinement, combined with initiatives such as the ECMS scheme, can help India build a strong domestic electronics components ecosystem

DQI Bureau



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The Indian Government has been pushing to boost the electronics components manufacturing across the country in order to strengthen India's semiconductor ecosystem.

Ashok Chandak, President, India Electronics and Semiconductor Association (IESA), stated: "The recent policy refinements around investments under the Press Note 3 framework represent a balanced and pragmatic step towards strengthening India's electronics manufacturing ecosystem, while safeguarding national interests. By providing clarity on beneficial ownership and introducing faster approval timelines, the government has created an enabling environment for attracting global capital and technology partnerships into upstream electronics manufacturing.

"India's electronics growth now requires strengthening the components and materials ecosystem, which is the missing layer in the country's manufacturing value chain. Investments in passive components such as MLCC capacitors, resistors and inductors, connectors and electromechanical components, PCB fabrication and materials, electronic capital goods, and semiconductor supply chain materials such as polysilicon and silicon wafers can significantly reduce import dependence and improve domestic manufacturing capabilities.

"These segments form the backbone of electronics manufacturing and account for nearly 40% of the bill of materials in electronic products."

Date	11th March
Publication	Business News For Profit
Link	https://businessnewsforprofit.com/news/government-push-to-boost-electronics-components-manufacturing-to-strengthen-indias-semiconductor-ecosystem/

Government Push to Boost Electronics Components Manufacturing to Strengthen India's Semiconductor Ecosystem

By team

MAR 11, 2026

IESA President Ashok Chandak Highlights Strategic Policy Refinements to Boost India's lectronics Manufacturing Ecosystem

New Delhi, Mar 11: Ashok Chandak, President of the **India Electronics and Semiconductor Association (IESA)**, welcomed the recent policy refinements under the Press Note 3 framework, emphasizing their potential to strengthen India's electronics manufacturing ecosystem while safeguarding national interests.

"The recent policy updates represent a balanced and pragmatic step towards creating an enabling environment for global capital and technology partnerships in upstream electronics manufacturing. By providing clarity on beneficial ownership and introducing faster approval timelines, the government is signaling its commitment to accelerating India's electronics growth," said Chandak.

Chandak underscored the importance of strengthening India's components and materials ecosystem, the "missing layer" in the country's manufacturing value chain. Key investment areas include **passive components** (MLCC capacitors, resistors, inductors), **connectors and electromechanical components**, **PCB fabrication and materials**, **electronic capital goods**, and **semiconductor supply chain materials** such as polysilicon and silicon wafers. "These segments account for nearly 40% of the bill of materials in electronic products. Expanding local manufacturing in these areas will reduce import dependence, improve domestic capabilities, and integrate India more deeply into global supply chains," he added.

Date	11th March
Publication	Cine BuZZ nEWS
Link	https://cinebuzznews.net/news/government-push-to-boost-electronics-components-manufacturing-to-strengthen-indias-semiconductor-ecosystem/

Government Push to Boost Electronics Components Manufacturing to Strengthen India's Semiconductor Ecosystem

on March 11, 2026 — Neel Achary

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Date	11th March
Publication	Media Bulletin News
Link	https://mediabulletins.com/news/government-push-to-boost-electronics-components-manufacturing-to-strengthen-indias-semiconductor-ecosystem/

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Date	11th March
Publication	Contentmedia Solution
Link	https://contentmediasolution.com/news/government-push-to-boost-electronics-components-manufacturing-to-strengthen-indias-semiconductor-ecosystem/

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Highlighting market potential, Chandak noted,

> **"India's current demand for passive components is estimated at $6–8 billion, connectors around $2–3 billion, and the PCB ecosystem exceeds $6 billion, creating a combined opportunity of $15–18 billion today. As India's electronics production expands, this could grow to $35–40 billion by 2030."**

Chandak also stressed the need for vigilance in ensuring that investments remain **non-strategic and non-controlling**, with strong safeguards on beneficial ownership, board representation, and technology access. "While India should actively leverage global capital and manufacturing capabilities, it is equally important to ensure that no external entity influences strategic decision-making or exerts undue pressure over critical technology sectors. Partnerships must be approached with a long-term national perspective rather than short-term gains," he commented.

Chandak concluded, "Combined with initiatives such as the **ECMS scheme**, these policy refinements can help India build a robust domestic electronics components ecosystem and unlock the next phase of growth in the country's electronics manufacturing journey."

Date	11th March
Publication	Pgurus
Link	https://www.pgurus.com/cabinet-eases-investment-rules-for-china-and-neighbouring-countries-sharing-land-borders-with-india/

Cabinet eases investment rules for China and neighbouring countries sharing land borders with India

Cabinet allows limited Chinese investments in key sectors

By **PGurus Newsdesk** · March 11, 2026

Government relaxes curbs on Chinese investments with safeguards

Limited Chinese investments allowed with strict safeguards

The **Union Cabinet of India** has approved changes to foreign investment rules allowing limited investments from companies based in countries that share land borders with India, including **China**, six years after **strict restrictions** were imposed.

Date	11th March
Publication	Money Control
Link	https://www.moneycontrol.com/technology/relaxed-fdi-norms-to-open-door-for-more-india-china-electronics-components-capital-goods-jvs-article-13856726.html

EXCLUSIVE Relaxed FDI norms to open door for more India–China electronics components, capital goods JVs

Indian manufacturers have been seeking partnerships with Chinese firms to gain access to technology, scale and cost efficiencies.

DANISH KHAN | MARCH 12, 2026 / 15:21 IST

Electronics

The Union Cabinet on Tuesday approved changes to Press Note 3 of 2020, easing foreign direct investment (FDI) rules for companies from countries sharing land borders with India — a move expected to unlock fresh investments in the electronics components ecosystem by enabling more joint ventures between Indian manufacturers and Chinese suppliers.

The decision, cleared at a Cabinet meeting chaired by Prime Minister Narendra Modi, comes as the domestic electronics industry has been pushing for faster approvals to build local supply chains and scale component manufacturing.

Indian manufacturers have been seeking partnerships with Chinese firms to gain access to technology, scale and cost efficiencies. Industry executives said several collaborations are being structured around the Centre's Electronics Component Manufacturing Scheme (ECMS), with companies looking for quicker approvals to tap into the Rs 40,000 crore incentive pool earmarked for component manufacturing.

The amendments to India's FDI rules for investments from countries sharing land borders with India introduce a formal definition of beneficial ownership, aligned with the Prevention of Money Laundering Rules, 2005, and apply the test at the level of the investor entity.

Date	11th March
Publication	MSN
Link	https://www.msn.com/en-in/news/india/cabinet-eases-investment-rules-for-china-and-neighbours-sharing-land-borders-with-india/ar-AA1XWpTZ

Cabinet eases investment rules for China and neighbours sharing land borders with India

Story by Rajeev Jayaswal • 3w • 3 min read

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Karnataka Budget 2026
Bengaluru - Print

Date	17th March
Publication	Sanje Samaya
Quote By	Ashok Chandak

ಕರ್ನಾಟಕ ಬಜೆಟ್ 2026ರಲ್ಲಿ ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್, ಸೆಮಿಕಂಡಕ್ಟರ್ ಮತ್ತು ಡೀಪ್-ಟೆಕ್ ಆವಿಷ್ಕಾರಕ್ಕೆ ಮಹತ್ವ

"ಕರ್ನಾಟಕ ಬಜೆಟ್ ಜಾಗತಿಕ ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಮತ್ತು ಸೆಮಿಕಂಡಕ್ಟರ್ ಉದ್ಯಮಕ್ಕೆ ಆಶಾದಾಯಕ ಸಂಕೇತವನ್ನು ಕಳುಹಿಸಿದೆ. ಇಎಸ್‌ಡಿಎಂ ಮತ್ತು ಸೆಮಿಕಂಡಕ್ಟರ್ ಹೂಡಿಕೆಗಳಿಗೆ ಅತ್ಯಂತ ಆಕರ್ಷಕ ತಾಣವಾಗಿ ಕರ್ನಾಟಕ ಹೊರಹೊಮ್ಮುತ್ತಿರುವುದು ಈಗ ಸ್ಪಷ್ಟವಾಗಿದ್ದು, ಅದಕ್ಕೆ ಪೂರಕವಾಗಿ ನೀತಿ ನಿರೂಪಣೆ ಮತ್ತು ತಂತ್ರಜ್ಞಾನ ನಾಯಕತ್ವ ಸಾಧಿಸುವ ಬದ್ಧತೆ ಹೊಂದಲಾಗಿದೆ. ಸೆಮಿಕಂಡಕ್ಟರ್ ಮತ್ತು ಇಎಸ್‌ಡಿಎಂ ವಲಯದ ಕಂಪನಿಗಳಿಂದ ಸುಮಾರು 45,000 ಕೋಟಿ ಹೂಡಿಕೆಯ ನಿರೀಕ್ಷೆಯು, ಜಾಗತಿಕ ಮಟ್ಟದ ತಂತ್ರಜ್ಞಾನ ಸಂಸ್ಥೆಗಳು ಕರ್ನಾಟಕದ ಮೇಲೆ ಇಟ್ಟಿರುವ ಗಾಢವಾದ ವಿಶ್ವಾಸವನ್ನು ತೋರಿಸುತ್ತದೆ," ಎಂದು ಐಇಎಸ್‌ಎ ಅಧ್ಯಕ್ಷರಾದ ಅಶೋಕ್ ಚಂದಕ್ ತಿಳಿಸಿದ್ದಾರೆ. ಬಜೆಟ್ ಕುರಿತು ಪ್ರತಿಕ್ರಿಯೆ ನೀಡಿದ ಅವರು, "ಅಷ್ಟೇ ಮಹತ್ವದ ಸಂಗತಿಯೆಂದರೆ, ಅತ್ಯಾಧುನಿಕ ತಂತ್ರಜ್ಞಾನಗಳು ಮತ್ತು ಪ್ರತಿಭೆಗಳ ಅಭಿವೃದ್ಧಿಗೆ ರಾಜ್ಯವು ಮಹತ್ವದ ಹೂಡಿಕೆಯನ್ನು ಮಾಡುತ್ತಿದೆ. ಇಸ್ರೋ ಮತ್ತು ಕಿಯೋನಿಕ್ಸ್ ಸಹಯೋಗದೊಂದಿಗೆ ಐಐಎಸ್ಸಿ ಅಡಿಯಲ್ಲಿ ಸ್ಥಾಪನೆಯಾಗಲಿರುವ ಬೆಂಗಳೂರು ರೋಬೊಟಿಕ್ಸ್ ಮತ್ತು ಎಐ ಇನ್ನೋವೇಶನ್ ಝೋನ್, ಐಬಿಎಬಿ, ಸಿ-ಕ್ಯಾಂಪ್ ಮತ್ತು ನಾಸ್ಕಾಂ ಸಹಯೋಗದೊಂದಿಗೆ ಆರಂಭವಾಗಲಿರುವ ಹಲವಾರು ಎಐ ಸೆಂಟರ್ ಆಫ್ ಎಕ್ಸಲೆನ್ಸ್ ಗಳು ಹಾಗೂ ಕರ್ನಾಟಕ ಕ್ವಾಂಟಮ್ ಟೆಕ್ನಾಲಜಿ ರೋಡ್ ಮ್ಯಾಪ್ ನಂತಹ ಯೋಜನೆಗಳು ಮುಂದಿನ ಪೀಳಿಗೆಯ ಸೆಮಿಕಂಡಕ್ಟರ್ ಮತ್ತು ಸುಧಾರಿತ ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಆವಿಷ್ಕಾರಕ್ಕೆ ಶಕ್ತಿ ತುಂಬುವ ಸಾಮರ್ಥ್ಯವನ್ನು ಹೊಂದಿವೆ" .

Date	17th March
Publication	Udayakala
Quote By	Ashok Chandak

ಬಜೆಟ್ 2026ರಲ್ಲಿ ಎಲೆಕ್ಟಾನಿಕ್ಸ್, ಸೆಮಿಕಂಡಕ್ಟರ್ ಮತ್ತು ಡೀಪ್-ಟೆಕ್ ಆವಿಷ್ಕಾರಕ್ಕೆ ಮಹತ್ವ: ಐಇಎಸ್‌ಎ

ಉದಯಕಾಲ ನ್ಯೂಸ್, ಬೆಂಗಳೂರು: ಕರ್ನಾಟಕ ಬಜೆಟ್ ಜಾಗತಿಕ ಎಲೆಕ್ಟಾನಿಕ್ಸ್ ಮತ್ತು ಸೆಮಿಕಂಡಕ್ಟರ್ ಉದ್ಯಮಕ್ಕೆ ಆಶಾದಾಯಕ ಸಂಕೇತವನ್ನು ಕಳುಹಿಸಿದೆ. ಇಎಸ್‌ಡಿಎಂ ಮತ್ತು ಸೆಮಿಕಂಡಕ್ಟರ್ ಹೂಡಿಕೆಗಳಿಗೆ ಅತ್ಯಂತ ಆಕರ್ಷಕ ತಾಣವಾಗಿ ಕರ್ನಾಟಕ ಹೊರಹೊಮ್ಮುತ್ತಿರುವುದು ಈಗ ಸ್ಪಷ್ಟವಾಗಿದ್ದು, ಅದಕ್ಕೆ ಪೂರಕವಾಗಿ ನೀತಿ ನಿರೂಪಣೆ ಮತ್ತು ತಂತ್ರಜ್ಞಾನ ನಾಯಕತ್ವ ಸಾಧಿಸುವ ಬದ್ಧತೆ ಹೊಂದಲಾಗಿದೆ. ಸೆಮಿಕಂಡಕ್ಟರ್ ಮತ್ತು ಇಎಸ್‌ಡಿಎಂ ವಲಯದ ಕಂಪನಿಗಳಿಂದ ಸುಮಾರು ರೂ.45,000 ಕೋಟಿ ಹೂಡಿಕೆಯ ನಿರೀಕ್ಷೆಯು, ಜಾಗತಿಕ ಮಟ್ಟದ ತಂತ್ರಜ್ಞಾನ ಸಂಸ್ಥೆಗಳು ಕರ್ನಾಟಕದ ಮೇಲೆ ಇಟ್ಟಿರುವ ಗಾಢವಾದ ವಿಶ್ವಾಸವನ್ನು ತೋರಿಸುತ್ತದೆ, ಎಂದು ಐಇಎಸ್‌ಎ ಅಧ್ಯಕ್ಷರಾದ ಅಶೋಕ್ ಚಂದಕ್ ತಿಳಿಸಿದ್ದಾರೆ.

ಬಜೆಟ್ ಕುರಿತು ಪ್ರತಿಕ್ರಿಯೆ ನೀಡಿದ ಅವರು, ಅಷ್ಟೇ ಮಹತ್ವದ ಸಂಗತಿಯೆಂದರೆ, ಆತ್ಯಾಧುನಿಕ ತಂತ್ರಜ್ಞಾನಗಳು ಮತ್ತು ಪ್ರತಿಭೆಗಳ ಅಭಿವೃದ್ಧಿಗೆ ರಾಜ್ಯವು ಮಹತ್ವದ ಹೂಡಿಕೆಯನ್ನು ಮಾಡುತ್ತಿದೆ. ಇಸ್ರೋ ಮತ್ತು ಕಿಯೋನಿಕ್ಸ್ ಸಹಯೋಗದೊಂದಿಗೆ ಐಐಎಸ್ಸಿ ಆವರಣದಲ್ಲಿ ಸ್ಥಾಪನೆಯಾಗಲಿರುವ ಬೆಂಗಳೂರು ರೋಬೊಟಿಕ್ಸ್ ಮತ್ತು ಎಐ ಇನ್ನೋವೇಶನ್ ಝೋನ್, ಐಐಎಬಿ, ಸಿ-ಕ್ಯಾಂಪ್ ಮತ್ತು ನಾಸ್ಕಾಂ ಸಹಯೋಗದೊಂದಿಗೆ ಆರಂಭವಾಗಲಿರುವ ಹಲವಾರು ಎಐ ಸೆಂಟರ್ ಆಫ್ ಎಕ್ಸ್‌ಲೆನ್ಸ್‌ಗಳು ಹಾಗೂ ಕರ್ನಾಟಕ ಕ್ವಾಂಟಮ್ ಟೆಕ್ನಾಲಜಿ ರೋಡ್ ಮ್ಯಾಪ್ ನಂತಹ ಯೋಜನೆಗಳು ಮುಂದಿನ ಪೀಳಿಗೆಯ ಸೆಮಿಕಂಡಕ್ಟರ್ ಮತ್ತು ಸುಧಾರಿತ ಎಲೆಕ್ಟಾನಿಕ್ಸ್ ಆವಿಷ್ಕಾರಕ್ಕೆ ಶಕ್ತಿ ತುಂಬುವ ಸಾಮರ್ಥ್ಯವನ್ನು ಹೊಂದಿವೆ ಎಂದು ಹೇಳಿದರು.

ರೂ. 1,000 ಕೋಟಿ ವೆಚ್ಚದ ಲೋಕಲ್ ಎಕಾನಮಿ ಆಕ್ಸಲರೇಟರ್ ಪ್ರೋಗ್ರಾಂ (ಲೀಪ್), ಕೆಡಿಇಎಂ ಜೊತೆಗಿನ ಸೂಪರ್-100 ಉದ್ಯಮ- ಶೈಕ್ಷಣಿಕ ದತ್ತು ಕಾರ್ಯಕ್ರಮ ಮತ್ತು ಕೆ-ಕಾಂಬಿನೇಟರ್ ನಂತಹ ಯೋಜನೆಗಳು ಎಲೆಕ್ಟಾನಿಕ್ಸ್ ಮತ್ತು ಸೆಮಿಕಂಡಕ್ಟರ್ ಮೌಲ್ಯವರ್ಧಿತ ಸರಪಳಿಗೆ ಪೂರಕವಾಗುವ ಸ್ಟಾರ್ಟ್ ಅಪ್ ಮತ್ತು ಆವಿಷ್ಕಾರ ವ್ಯವಸ್ಥೆಯನ್ನು ಮತ್ತಷ್ಟು ಬಲಪಡಿಸುತ್ತವೆ. ಹೊಸ ಐಟಿ ನೀತಿ 2025-30ರ ಅಡಿಯಲ್ಲಿ ಸಾಫ್ಟ್ ವೇರ್ ರಫ್ತಿನಲ್ಲಿ ರೂ.11.5 ಲಕ್ಷ ಕೋಟಿಗಳ ಮಹತ್ವಾಕಾಂಕ್ಷೆಯ ಗುರಿ ಮತ್ತು ಜಾಗತಿಕ ಸಾಮರ್ಥ್ಯ ಕೇಂದ್ರಗಳ ನಿರಂತರ ವಿಸ್ತರಣೆಯೊಂದಿಗೆ ಕರ್ನಾಟಕವು ಭಾರತದ ಪ್ರಮುಖ ಡೀಪ್- ಟೆಕ್ ಮತ್ತು ಎಲೆಕ್ಟಾನಿಕ್ಸ್ ಆವಿಷ್ಕಾರ ಕೇಂದ್ರವಾಗಿ ತನ್ನ ಸ್ಥಾನವನ್ನು ಗಟ್ಟಿಗೊಳಿಸುತ್ತಿದೆ ಎಂದು ಅವರು ಹೇಳಿದರು.

ವಿನ್ಯಾಸ, ಬಿಡಿಭಾಗಗಳು, ವ್ಯವಸ್ಥೆಗಳು, ಉಪಕರಣಗಳು ಮತ್ತು ಪೂರೈಕೆ ಸರಪಳಿ ಪಾಲುದಾರರನ್ನು ಒಳಗೊಂಡ ಪ್ರಬಲ ಸೆಮಿಕಂಡಕ್ಟರ್ ಮತ್ತು ಎಲೆಕ್ಟಾನಿಕ್ಸ್ ಉತ್ಪಾದನಾ ಪರಿಸರ ವ್ಯವಸ್ಥೆಯ ಬೆಳವಣಿಗೆಯನ್ನು ಈ ಯೋಜನೆಗಳು ವೇಗಗೊಳಿಸುತ್ತವೆ ಎಂದು ಐಇಎಸ್‌ಎ ನಂಬುತ್ತದೆ.

Date	17th March
Publication	Sanje Express
Quote By	Ashok Chandak

ಕರ್ನಾಟಕ ಬಜೆಟ್ 2026ರಲ್ಲಿ ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್, ಸೆಮಿಕಂಡಕ್ಟರ್ ಮತ್ತು ಡೀಪ್-ಟೆಕ್ ಆವಿಷ್ಕಾರಕ್ಕೆ ಮಹತ್ವ: ಐಇಎಸ್ಎ ಐಇಎಸ್ಎ ಅಧ್ಯಕ್ಷರಾದ ಅಶೋಕ್ ಚಂದಕ್ ಪ್ರತಿಕ್ರಿಯೆ

ಕರ್ನಾಟಕ ಬಜೆಟ್ ಜಾಗತಿಕ ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಮತ್ತು ಸೆಮಿಕಂಡಕ್ಟರ್ ಉದ್ಯಮಕ್ಕೆ ಆಶಾದಾಯಕ ಸಂಕೇತವನ್ನು ಕಳುಹಿಸಿದೆ. ಇಎಸ್‌ಡಿಎಂ ಮತ್ತು ಸೆಮಿಕಂಡಕ್ಟರ್ ಹೂಡಿಕೆಗಳಿಗೆ ಅತ್ಯಂತ ಆಕರ್ಷಕ ತಾಣವಾಗಿ ಕರ್ನಾಟಕ ಹೊರಹೊಮ್ಮುತ್ತಿರುವುದು ಈಗ ಸ್ಪಷ್ಟವಾಗಿದ್ದು, ಅದಕ್ಕೆ ಪೂರಕವಾಗಿ ನೀತಿ ನಿರೂಪಣೆ ಮತ್ತು ತಂತ್ರಜ್ಞಾನ ನಾಯಕತ್ವ ಸಾಧಿಸುವ ಬದ್ಧತೆ ಹೊಂದಲಾಗಿದೆ. ಸೆಮಿಕಂಡಕ್ಟರ್ ಮತ್ತು ಇಎಸ್‌ಡಿಎಂ ವಲಯದ ಕಂಪನಿಗಳಿಂದ ಸುಮಾರು 45,000 ಕೋಟಿ ಹೂಡಿಕೆಯ ನಿರೀಕ್ಷೆಯು, ಜಾಗತಿಕ ಮಟ್ಟದ ತಂತ್ರಜ್ಞಾನ ಸಂಸ್ಥೆಗಳು ಕರ್ನಾಟಕದ ಮೇಲೆ ಇಟ್ಟಿರುವ ಗಾಢವಾದ ವಿಶ್ವಾಸವನ್ನು ತೋರಿಸುತ್ತದೆ," ಎಂದು ಐಇಎಸ್‌ಎ ಅಧ್ಯಕ್ಷರಾದ ಅಶೋಕ್ ಚಂದಕ್ ತಿಳಿಸಿದ್ದಾರೆ. ಬಜೆಟ್ ಕುರಿತು ಪ್ರತಿಕ್ರಿಯೆ ನೀಡಿದ ಅವರು, "ಅಷ್ಟೇ ಮಹತ್ವದ ಸಂಗತಿಯೆಂದರೆ, ಅತ್ಯಾಧುನಿಕ ತಂತ್ರಜ್ಞಾನಗಳು ಮತ್ತು ಪ್ರತಿಭೆಗಳ ಅಭಿವೃದ್ಧಿಗೆ ರಾಜ್ಯವು ಮಹತ್ವದ ಹೂಡಿಕೆಯನ್ನು ಮಾಡುತ್ತಿದೆ. ಇಸ್ರೋ ಮತ್ತು ಕಿಯೋನಿಕ್ಸ್ ಸಹಯೋಗದೊಂದಿಗೆ ಐಐಎಸ್ಸಿ ಅಡಿಯಲ್ಲಿ ಸ್ಥಾಪನೆಯಾಗಲಿರುವ ಬೆಂಗಳೂರು ರೋಬೊಟಿಕ್ಸ್ ಮತ್ತು ಎಐ ಇನ್ನೋವೇಶನ್ ಝೋನ್, ಐಐಎಬಿ, ಸಿ-ಕ್ಯಾಂಪ್ ಮತ್ತು ನಾಸ್ಕಾಂ ಸಹಯೋಗದೊಂದಿಗೆ ಆರಂಭವಾಗಲಿರುವ ಹಲವಾರು ಎಐ ಸೆಂಟರ್ ಆಫ್ ಎಕ್ಸಲೆನ್ಸ್ ಗಳು ಹಾಗೂ ಕರ್ನಾಟಕ ಕ್ವಾಂಟಮ್ ಟಿಕ್ನಾಲಜಿ ರೋಡ್ ಮ್ಯಾಪ್ ನಂತಹ ಯೋಜನೆಗಳು ಮುಂದಿನ ಪೀಳಿಗೆಯ ಸೆಮಿಕಂಡಕ್ಟರ್ ಮತ್ತು ಸುಧಾರಿತ ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಆವಿಷ್ಕಾರಕ್ಕೆ ಶಕ್ತಿ ತುಂಬುವ ಸಾಮರ್ಥ್ಯವನ್ನು ಹೊಂದಿವೆ" ಎಂದು ಹೇಳಿದರು. 1,000 ಕೋಟಿ ವೆಚ್ಚದ ಲೋಕಲ್ ಎಕಾನಮಿ ಆಕ್ಸಿಲರೇಟರ್ ಪ್ರೋಗ್ರಾಂ (ಲೀಪ್), ಕೆಡಿಇಎಂ ಸ್ಥಾನವನ್ನು ಜೊತೆಗಿನ ಸೂಪರ್-100 ಉದ್ಯಮ- ಶೈಕ್ಷಣಿಕ ದತ್ತು ಕಾರ್ಯಕ್ರಮ ಮತ್ತು ಕೆ-ಕಾಂಬಿನೇಟರ್ ನಂತಹ ಯೋಜನೆಗಳು ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಮತ್ತು ಸೆಮಿಕಂಡಕ್ಟರ್ ಮೌಲ್ಯವರ್ಧಿತ ಪೂರಕವಾಗುವ ಸ್ಟಾರ್ಟ್ ಅಪ್ ಮತ್ತು ಆವಿಷ್ಕಾರ ವ್ಯವಸ್ಥೆಯನ್ನು ಮತ್ತಷ್ಟು ಬಲಪಡಿಸುತ್ತವೆ. ಹೊಸ ಐಟಿ ನೀತಿ 2025-30ರ ಅಡಿಯಲ್ಲಿ ಸಾಫ್ಟ್ ವೇರ್ ರಫ್ತಿನಲ್ಲಿ 11.5 ಲಕ್ಷ ಕೋಟಿಗಳ ಮಹತ್ವಾಕಾಂಕ್ಷೆಯ ಗುರಿ ಮತ್ತು ಜಾಗತಿಕ ಸಾಮರ್ಥ್ಯ ಕೇಂದ್ರಗಳ ನಿರಂತರ ವಿಸ್ತರಣೆಯೊಂದಿಗೆ ಕರ್ನಾಟಕವು ಭಾರತದ ಪ್ರಮುಖ ಡೀಪ್- ಟೆಕ್ ಮತ್ತು ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಆವಿಷ್ಕಾರ ಕೇಂದ್ರವಾಗಿ ತನ್ನ ಸ್ಥಾನವನ್ನು ಗಟ್ಟಿಗೊಳಿಸುತ್ತಿದೆ" ಎಂದು ಅವರು ಹೇಳಿದರು."ವಿನ್ಯಾಸ, ಬಿಡಿಭಾಗಗಳು, ವ್ಯವಸ್ಥೆಗಳು, ಉಪಕರಣಗಳು ಮತ್ತು ಪೂರೈಕೆ ಸರಪಳಿ ಪಾಲುದಾರರನ್ನು ಒಳಗೊಂ ಪ್ರಬಲ ಸೆಮಿಕಂಡಕ್ಟರ್ ಮತ್ತು ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಉತ್ಪಾದನಾ ಪರಿಸರ ವ್ಯವಸ್ಥೆಯ ಬೆಳವಣಿಗೆಯನ್ನು ಈ ಯೋಜನೆಗಳು ವೇಗಗೊಳಿಸುತ್ತವೆ.

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Quote By	Ashok Chandak

ಕರ್ನಾಟಕ ಬಜೆಟ್ 2026ರಲ್ಲಿ ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್, ಸೆಮಿಕಂಡಕ್ಟರ್ ಮತ್ತು ಡೀಪ್-ಟೆಕ್ ಆವಿಷ್ಕಾರಕ್ಕೆ ಮಹತ್ವ

"ಕರ್ನಾಟಕ ಬಜೆಟ್ ಜಾಗತಿಕ ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಮತ್ತು ಸೆಮಿಕಂಡಕ್ಟರ್ ಉದ್ಯಮಕ್ಕೆ ಆಶಾದಾಯಕ ಸಂಕೇತವನ್ನು ಕಳುಹಿಸಿದೆ. ಇಎಸ್‌ಡಿಎಂ ಮತ್ತು ಸೆಮಿಕಂಡಕ್ಟರ್ ಹೂಡಿಕೆಗಳಿಗೆ ಅತ್ಯಂತ ಆಕರ್ಷಕ ತಾಣವಾಗಿ ಕರ್ನಾಟಕ ಹೊರಹೊಮ್ಮುತ್ತಿರುವುದು ಈಗ ಸ್ಪಷ್ಟವಾಗಿದ್ದು, ಅದಕ್ಕೆ ಪೂರಕವಾಗಿ ನೀತಿ ನಿರೂಪಣೆ ಮತ್ತು ತಂತ್ರಜ್ಞಾನ ನಾಯಕತ್ವ ಸಾಧಿಸುವ ಬದ್ಧತೆ ಹೊಂದಲಾಗಿದೆ. ಸೆಮಿಕಂಡಕ್ಟರ್ ಮತ್ತು ಇಎಸ್‌ಡಿಎಂ ವಲಯದ ಕಂಪನಿಗಳಿಂದ ಸುಮಾರು 45,000 ಕೋಟಿ ಹೂಡಿಕೆಯ ನಿರೀಕ್ಷೆಯು, ಜಾಗತಿಕ ಮಟ್ಟದ ತಂತ್ರಜ್ಞಾನ ಸಂಸ್ಥೆಗಳು ಕರ್ನಾಟಕದ ಮೇಲೆ ಇಟ್ಟಿರುವ ಗಾಢವಾದ ವಿಶ್ವಾಸವನ್ನು ತೋರಿಸುತ್ತದೆ," ಎಂದು ಐಇಎಸ್‌ಎ ಅಧ್ಯಕ್ಷರಾದ ಅಶೋಕ್ ಚಂದಕ್ ತಿಳಿಸಿದ್ದಾರೆ. ಬಜೆಟ್ ಕುರಿತು ಪ್ರತಿಕ್ರಿಯೆ ನೀಡಿದ ಅವರು, "ಅಷ್ಟೇ ಮಹತ್ವದ ಸಂಗತಿಯೆಂದರೆ, ಅತ್ಯಾಧುನಿಕ ತಂತ್ರಜ್ಞಾನಗಳು ಮತ್ತು ಪ್ರತಿಭೆಗಳ ಅಭಿವೃದ್ಧಿಗೆ ರಾಜ್ಯವು ಮಹತ್ವದ ಹೂಡಿಕೆಯನ್ನು ಮಾಡುತ್ತಿದೆ. ಇಸ್ರೋ ಮತ್ತು ಕಿಯೋನಿಕ್ಸ್ ಸಹಯೋಗದೊಂದಿಗೆ ಐಐಎಸ್ಸಿ ಅಡಿಯಲ್ಲಿ ಸ್ಥಾಪನೆಯಾಗಲಿರುವ ಬೆಂಗಳೂರು ರೋಬೊಟಿಕ್ಸ್ ಮತ್ತು ಎಐ ಇನ್ನೋವೇಶನ್ ಝೋನ್, ಐಬಿಎಬಿ, ಸಿ-ಕ್ಯಾಂಪ್ ಮತ್ತು ನಾಸ್ಕಾಂ ಸಹಯೋಗದೊಂದಿಗೆ ಆರಂಭವಾಗಲಿರುವ ಹಲವಾರು ಎಐ ಸೆಂಟರ್ ಆಫ್ ಎಕ್ಸಲೆನ್ಸ್ ಗಳು ಹಾಗೂ ಕರ್ನಾಟಕ ಕ್ವಾಂಟಮ್ ಟೆಕ್ನಾಲಜಿ ರೋಡ್ ಮ್ಯಾಪ್ ನಂತಹ ಯೋಜನೆಗಳು ಮುಂದಿನ ಪೀಳಿಗೆಯ ಸೆಮಿಕಂಡಕ್ಟರ್ ಮತ್ತು ಸುಧಾರಿತ ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಆವಿಷ್ಕಾರಕ್ಕೆ ಶಕ್ತಿ ತುಂಬುವ ಸಾಮರ್ಥ್ಯವನ್ನು ಹೊಂದಿವೆ".

Date	17th March
Publication	UdayaKala
Quote By	Ashok Chandak

ಬಜೆಟ್ 2026ರಲ್ಲಿ ಎಲೆಕ್ಟಾನಿಕ್ಸ್, ಸೆಮಿಕಂಡಕ್ಟರ್ ಮತ್ತು ಡೀಪ್-ಟೆಕ್ ಆವಿಷ್ಕಾರಕ್ಕೆ ಮಹತ್ವ: ಐಇಎಸ್‌ಎ

ಉದಯಕಾಲ ನ್ಯೂಸ್, ಬೆಂಗಳೂರು: ಕರ್ನಾಟಕ ಬಜೆಟ್ ಜಾಗತಿಕ ಎಲೆಕ್ಟಾನಿಕ್ಸ್ ಮತ್ತು ಸೆಮಿಕಂಡಕ್ಟರ್ ಉದ್ಯಮಕ್ಕೆ ಆಶಾದಾಯಕ ಸಂಕೇತವನ್ನು ಕಳುಹಿಸಿದೆ. ಇಎಸ್‌ಡಿಎಂ ಮತ್ತು ಸೆಮಿಕಂಡಕ್ಟರ್ ಹೂಡಿಕೆಗಳಿಗೆ ಅತ್ಯಂತ ಆಕರ್ಷಕ ತಾಣವಾಗಿ ಕರ್ನಾಟಕ ಹೊರಹೊಮ್ಮುತ್ತಿರುವುದು ಈಗ ಸ್ಪಷ್ಟವಾಗಿದ್ದು, ಅದಕ್ಕೆ ಪೂರಕವಾಗಿ ನೀತಿ ನಿರೂಪಣೆ ಮತ್ತು ತಂತ್ರಜ್ಞಾನ ನಾಯಕತ್ವ ಸಾಧಿಸುವ ಬದ್ಧತೆ ಹೊಂದಲಾಗಿದೆ. ಸೆಮಿಕಂಡಕ್ಟರ್ ಮತ್ತು ಇಎಸ್‌ಡಿಎಂ ವಲಯದ ಕಂಪನಿಗಳಿಂದ ಸುಮಾರು ರೂ.45,000 ಕೋಟಿ ಹೂಡಿಕೆಯ ನಿರೀಕ್ಷೆಯು, ಜಾಗತಿಕ ಮಟ್ಟದ ತಂತ್ರಜ್ಞಾನ ಸಂಸ್ಥೆಗಳು ಕರ್ನಾಟಕದ ಮೇಲೆ ಇಟ್ಟಿರುವ ಗಾಢವಾದ ವಿಶ್ವಾಸವನ್ನು ತೋರಿಸುತ್ತದೆ, ಎಂದು ಐಇಎಸ್‌ಎ ಅಧ್ಯಕ್ಷರಾದ ಅಶೋಕ್ ಚಂದಕ್ ತಿಳಿಸಿದ್ದಾರೆ.

ಬಜೆಟ್ ಕುರಿತು ಪ್ರತಿಕ್ರಿಯೆ ನೀಡಿದ ಅವರು, ಅಷ್ಟೇ ಮಹತ್ವದ ಸಂಗತಿಯೆಂದರೆ, ಅತ್ಯಾಧುನಿಕ ತಂತ್ರಜ್ಞಾನಗಳು ಮತ್ತು ಪ್ರತಿಭೆಗಳ ಅಭಿವೃದ್ಧಿಗೆ ರಾಜ್ಯವು ಮಹತ್ವದ ಹೂಡಿಕೆಯನ್ನು ಮಾಡುತ್ತಿದೆ. ಇಸ್ರೋ ಮತ್ತು ಕಿಯೋನಿಕ್ಸ್ ಸಹಯೋಗದೊಂದಿಗೆ ಐಐಎಸ್ಸಿ ಆಡಿಯಲ್ಲಿ ಸ್ಥಾಪನೆಯಾಗಲಿರುವ ಬೆಂಗಳೂರು ರೋಬೊಟಿಕ್ಸ್ ಮತ್ತು ಎಐ ಇನ್ನೋವೇಶನ್ ಝೋನ್, ಐಐಎಬಿ, ಸಿ-ಕ್ಯಾಂಪ್ ಮತ್ತು ನಾಸ್ಕಾಂ ಸಹಯೋಗದೊಂದಿಗೆ ಆರಂಭವಾಗಲಿರುವ ಹಲವಾರು ಎಐ ಸೆಂಟರ್ ಆಫ್ ಎಕ್ಸ್ ಲೆನ್ಸ್‌ಗಳು ಹಾಗೂ ಕರ್ನಾಟಕ ಕ್ವಾಂಟಮ್ ಟೆಕ್ನಾಲಜಿ ರೋಡ್ ಮ್ಯಾಪ್ ನಂತಹ ಯೋಜನೆಗಳು ಮುಂದಿನ ಪೀಳಿಗೆಯ ಸೆಮಿಕಂಡಕ್ಟರ್ ಮತ್ತು ಸುಧಾರಿತ ಎಲೆಕ್ಟಾನಿಕ್ಸ್ ಆವಿಷ್ಕಾರಕ್ಕೆ ಶಕ್ತಿ ತುಂಬುವ ಸಾಮರ್ಥ್ಯವನ್ನು ಹೊಂದಿವೆ ಎಂದು ಹೇಳಿದರು.

ರೂ. 1,000 ಕೋಟಿ ವೆಚ್ಚದ ಲೋಕಲ್ ಎಕಾನಮಿ ಆಕ್ಸಿಲರೇಟರ್ ಪ್ರೋಗ್ರಾಂ (ಲೀಪ್), ಕೆಡಿಇಎಂ ಜೊತೆಗಿನ ಸೂಪರ್-100 ಉದ್ಯಮ- ಶೈಕ್ಷಣಿಕ ದತ್ತು ಕಾರ್ಯಕ್ರಮ ಮತ್ತು ಕೆ-ಕಾಂಬಿನೇಟರ್ ನಂತಹ ಯೋಜನೆಗಳು ಎಲೆಕ್ಟಾನಿಕ್ಸ್ ಮತ್ತು ಸೆಮಿಕಂಡಕ್ಟರ್ ಮೌಲ್ಯವರ್ಧಿತ ಸರಪಳಿಗೆ ಪೂರಕವಾಗುವ ಸ್ಟಾರ್ಟ್ ಅಪ್ ಮತ್ತು ಆವಿಷ್ಕಾರ ವ್ಯವಸ್ಥೆಯನ್ನು ಮತ್ತಷ್ಟು ಬಲಪಡಿಸುತ್ತವೆ. ಹೊಸ ಐಟಿ ನೀತಿ 2025-30ರ ಆಡಿಯಲ್ಲಿ ಸಾಫ್ಟ್ ವೇರ್ ರಫ್ತಿನಲ್ಲಿ ರೂ.11.5 ಲಕ್ಷ ಕೋಟಿಗಳ ಮಹತ್ವಾಕಾಂಕ್ಷೆಯ ಗುರಿ ಮತ್ತು ಜಾಗತಿಕ ಸಾಮರ್ಥ್ಯ ಕೇಂದ್ರಗಳ ನಿರಂತರ ವಿಸ್ತರಣೆಯೊಂದಿಗೆ ಕರ್ನಾಟಕವು ಭಾರತದ ಪ್ರಮುಖ ಡೀಪ್- ಟೆಕ್ ಮತ್ತು ಎಲೆಕ್ಟಾನಿಕ್ಸ್ ಆವಿಷ್ಕಾರ ಕೇಂದ್ರವಾಗಿ ತನ್ನ ಸ್ಥಾನವನ್ನು ಗಟ್ಟಿಗೊಳಿಸುತ್ತಿದೆ ಎಂದು ಅವರು ಹೇಳಿದರು.

ವಿನ್ಯಾಸ, ಬಿಡಿಭಾಗಗಳು, ವ್ಯವಸ್ಥೆಗಳು, ಉಪಕರಣಗಳು ಮತ್ತು ಪೂರೈಕೆ ಸರಪಳಿ ಪಾಲುದಾರರನ್ನು ಒಳಗೊಂ ಪ್ರಬಲ ಸೆಮಿ ಕಂಡಕ್ಟರ್ ಮತ್ತು ಎಲೆಕ್ಟಾನಿಕ್ಸ್ ಉತ್ಪಾದನಾ ಪರಿಸರ ವ್ಯವಸ್ಥೆಯ ಬೆಳವಣಿಗೆಯನ್ನು ಈ ಯೋಜನೆಗಳು ವೇಗಗೊಳಿಸುತ್ತವೆ ಎಂದು ಐಇಎಸ್‌ಎ ನಂಬುತ್ತದೆ.

Date	12th March
Publication	Suvarna Times of Karnatak
Quote By	Ashok Chandak

ಕರ್ನಾಟಕ ಬಜೆಟ್ 2026ರಲ್ಲಿ ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ , ಸೆಮಿಕಂಡಕ್ಟರ್ ಮತ್ತು ಡೀಪ್-ಟೆಕ್ ಆವಿಷ್ಕಾರಕ್ಕೆ ಮಹತ್ವ: ಐಇಎಸ್ಎ

ಬೆಂಗಳೂರು: ಕರ್ನಾಟಕ ಬಜೆಟ್ ಜಾಗತಿಕ ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಮತ್ತು ಸೆಮಿಕಂಡಕ್ಟರ್ ಉದ್ಯಮಕ್ಕೆ ಆಶಾದಾಯಕ ಸಂಕೇತವನ್ನು ಕಳುಹಿಸಿದೆ. ಇಎಸ್‌ಡಿಎಂ ಮತ್ತು ಸೆಮಿಕಂಡಕ್ಟರ್ ಹೂಡಿಕೆಗಳಿಗೆ ಅತ್ಯಂತ ಆಕರ್ಷಕ ತಾಣವಾಗಿ ಕರ್ನಾಟಕ ಹೊರಹೊಮ್ಮುತ್ತಿರುವುದು ಈಗ ಸ್ಪಷ್ಟವಾಗಿದ್ದು, ಅದಕ್ಕೆ ಪೂರಕವಾಗಿ ನೀತಿ ನಿರೂಪಣೆ ಮತ್ತು ತಂತ್ರಜ್ಞಾನ ನಾಯಕತ್ವ ಸಾಧಿಸುವ ಬದ್ಧತೆ ಹೊಂದಲಾಗಿದೆ. ಸೆಮಿಕಂಡಕ್ಟರ್ ಮತ್ತು ಇಎಸ್‌ಡಿಎಂ ವಲಯದ ಕಂಪನಿಗಳಿಂದ ಸುಮಾರು ರೂ.45,000 ಕೋಟಿ ಹೂಡಿಕೆಯ ನಿರೀಕ್ಷೆಯು, ಜಾಗತಿಕ ಮಟ್ಟದ ತಂತ್ರಜ್ಞಾನ ಸಂಸ್ಥೆಗಳು ಕರ್ನಾಟಕದ ಮೇಲೆ ಇಟ್ಟಿರುವ ಗಾಢವಾದ ವಿಶ್ವಾಸವನ್ನು ತೋರಿಸುತ್ತದೆ, ಎಂದು ಐಇಎಸ್‌ಎ ಅಧ್ಯಕ್ಷರಾದ ಅಶೋಕ್ ಚಂದಕ್ ತಿಳಿಸಿದ್ದಾರೆ.

ಬಜೆಟ್ ಕುರಿತು ಪ್ರತಿಕ್ರಿಯೆ ನೀಡಿದ ಅವರು, ಅಷ್ಟೇ ಮಹತ್ವದ ಸಂಗತಿಯೆಂದರೆ, ಅತ್ಯಾಧುನಿಕ ತಂತ್ರಜ್ಞಾನಗಳು ಮತ್ತು ಪ್ರತಿಭೆಗಳ ಅಭಿವೃದ್ಧಿಗೆ ರಾಜ್ಯವು ಮಹತ್ವದ ಹೂಡಿಕೆಯನ್ನು ಮಾಡುತ್ತಿದೆ. ಇಸ್ರೋ ಮತ್ತು ಕಿಯೋನಿಕ್ಸ್ ಸಹಯೋಗದೊಂದಿಗೆ ಐಐಎಸ್ಸಿ ಅಡಿಯಲ್ಲಿ ಸ್ಥಾಪನೆಯಾಗಲಿರುವ ಬೆಂಗಳೂರು ರೋಬೊಟಿಕ್ಸ್ ಮತ್ತು ಎಐ ಇನ್ನೋವೇಶನ್ ಝೋನ್, ಐಬಿಎಬಿ, ಸಿ-ಕ್ಯಾಂಪ್ ಮತ್ತು ನಾಸ್ಕಾಂ ಸಹಯೋಗದೊಂದಿಗೆ ಆರಂಭವಾಗಲಿರುವ ಹಲವಾರು ಎಐ ಸೆಂಟರ್ ಆಫ್ ಎಕ್ಸಲೆನ್ಸ್ ಗಳು ಹಾಗೂ ಕರ್ನಾಟಕ ಕ್ವಾಂಟಮ್ ಟೆಕ್ನಾಲಜಿ ರೋಡ್ ಮ್ಯಾಪ್ ನಂತಹ ಯೋಜನೆಗಳು ಮುಂದಿನ ಪೀಳಿಗೆಯ ಸೆಮಿಕಂಡಕ್ಟರ್ ಮತ್ತು ಸುಧಾರಿತ ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಆವಿಷ್ಕಾರಕ್ಕೆ ಶಕ್ತಿ ತುಂಬುವ ಸಾಮರ್ಥ್ಯವನ್ನು ಹೊಂದಿವೆ ಎಂದು ಹೇಳಿದರು.

ರೂ. 1,000 ಕೋಟಿ ವೆಚ್ಚದ ಲೋಕಲ್ ಎಕಾನಮಿ ಆಕ್ಸಿಲರೇಟರ್ ಪ್ರೋಗ್ರಾಂ (ಲೀಪ್), ಕೆಡಿಇಎಂ ಜೊತೆಗಿನ ಸೂಪರ್-100 ಉದ್ಯಮ- ಶೈಕ್ಷಣಿಕ ದತ್ತು ಕಾರ್ಯಕ್ರಮ ಮತ್ತು ಕೆ-ಕಾಂಬಿನೇಟರ್ ನಂತಹ ಯೋಜನೆಗಳು ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಮತ್ತು ಸೆಮಿಕಂಡಕ್ಟರ್ ಮೌಲ್ಯವರ್ಧಿತ ಸರಪಳಿಗೆ ಪೂರಕವಾಗುವ ಸ್ಟಾರ್ಟ್ ಅಪ್ ಮತ್ತು ಆವಿಷ್ಕಾರ ವ್ಯವಸ್ಥೆಯನ್ನು ಮತ್ತಷ್ಟು ಬಲಪಡಿಸುತ್ತವೆ.

Date	12th March
Publication	Arambha
Quote By	Ashok Chandak

ಬಜೆಟ್ 2026ರಲ್ಲಿ ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್, ಸೆಮಿಕಂಡಕ್ಟರ್ ಮತ್ತು ಡೀಪ್–ಟೆಕ್ ಆವಿಷ್ಕಾರಕ್ಕೆ ಮಹತ್ವ

ಬೆಂಗಳೂರು: "ಕರ್ನಾಟಕ ಬಜೆಟ್ ಜಾಗತಿಕ ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಮತ್ತು ಸೆಮಿಕಂಡಕ್ಟರ್ ಉದ್ಯಮಕ್ಕೆ ಆಶಾದಾಯಕ ಸಂಕೇತವನ್ನು ಕಳುಹಿಸಿದೆ. ಇಎಸ್‌ಡಿಎಂ ಮತ್ತು ಸೆಮಿಕಂಡಕ್ಟರ್ ಹೂಡಿಕೆಗಳಿಗೆ ಅತ್ಯಂತ ಆಕರ್ಷಕ ತಾಣವಾಗಿ ಕರ್ನಾಟಕ ಹೊರಹೊಮ್ಮುತ್ತಿರುವುದು ಈಗ ಸ್ಪಷ್ಟವಾಗಿದ್ದು, ಅದಕ್ಕೆ ಪೂರಕವಾಗಿ ನೀತಿ ನಿರೂಪಣೆ ಮತ್ತು ತಂತ್ರಜ್ಞಾನ ನಾಯಕತ್ವ ಸಾಧಿಸುವ ಬದ್ಧತೆ ಹೊಂದಲಾಗಿದೆ. ಸೆಮಿಕಂಡಕ್ಟರ್ ಮತ್ತು ಇಎಸ್‌ಡಿಎಂ ವಲಯದ ಕಂಪನಿಗಳಿಂದ ಸುಮಾರು ರೂ.45,000 ಕೋಟಿ ಹೂಡಿಕೆಯ ನಿರೀಕ್ಷೆಯು, ಜಾಗತಿಕ ಮಟ್ಟದ ತಂತ್ರಜ್ಞಾನ ಸಂಸ್ಥೆಗಳು ಕರ್ನಾಟಕದ ಮೇಲೆ ಇಟ್ಟಿರುವ ಗಾಢವಾದ ವಿಶ್ವಾಸವನ್ನು ತೋರಿಸುತ್ತದೆ," ಎಂದು ಐಇಎಸ್‌ಎ ಅಧ್ಯಕ್ಷರಾದ ಅಶೋಕ್ ಚಂದಕ್ ತಿಳಿಸಿದ್ದಾರೆ.

ಬಜೆಟ್ ಕುರಿತು ಪ್ರತಿಕ್ರಿಯೆ ನೀಡಿದ ಅವರು, "ಅಷ್ಟೇ ಮಹತ್ವದ ಸಂಗತಿಯೆಂದರೆ, ಅತ್ಯಾಧುನಿಕ ತಂತ್ರಜ್ಞಾನಗಳು ಮತ್ತು ಪ್ರತಿಭೆಗಳ ಅಭಿವೃದ್ಧಿಗೆ ರಾಜ್ಯವು ಮಹತ್ವದ ಹೂಡಿಕೆಯನ್ನು ಮಾಡುತ್ತಿದೆ. ಇಸ್ರೋ ಮತ್ತು ಕಿಯೋನಿಕ್ಸ್ ಸಹಯೋಗದೊಂದಿಗೆ ಐಐಎಸ್ಸಿ ಅಡಿಯಲ್ಲಿ ಸ್ಥಾಪನೆಯಾಗಲಿರುವ ಬೆಂಗಳೂರು ರೋಬೊಟಿಕ್ಸ್ ಮತ್ತು ಎಐ ಇನ್ನೋವೇಶನ್ ಝೋನ್, ಐಐಎಬಿ, ಸಿ–ಕ್ಯಾಂಪ್ ಮತ್ತು ನಾಸ್ಕಾಂ ಸಹಯೋಗದೊಂದಿಗೆ ಆರಂಭವಾಗಲಿರುವ ಹಲವಾರು ಎಐ ಸೆಂಟರ್ ಆಫ್ ಎಕ್ಸಲೆನ್ಸ್ ಗಳು ಹಾಗೂ ಕರ್ನಾಟಕ ಕ್ವಾಂಟಮ್ ಟೆಕ್ನಾಲಜಿ ರೋಡ್ ಮ್ಯಾಪ್ ನಂತಹ ಯೋಜನೆಗಳು ಮುಂದಿನ ಪೀಳಿಗೆಯ ಸೆಮಿಕಂಡಕ್ಟರ್ ಮತ್ತು ಸುಧಾರಿತ ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಆವಿಷ್ಕಾರಕ್ಕೆ ಶಕ್ತಿ ತುಂಬುವ ಸಾಮರ್ಥ್ಯವನ್ನು ಹೊಂದಿವೆ" ಎಂದು ಹೇಳಿದರು. "ರೂ. 1,000 ಕೋಟಿ ವೆಚ್ಚದ ಲೋಕಲ್ ಎಕಾನಮಿ ಆಕ್ಸಿಲರೇಟರ್ ಪ್ರೋಗ್ರಾಂ (ಲೀಪ್), ಕೆಡಿಇಎಂ ಜೊತೆಗಿನ ಸೂಪರ್–100 ಉದ್ಯಮ– ಶೈಕ್ಷಣಿಕ ದತ್ತು ಕಾರ್ಯಕ್ರಮ ಮತ್ತು ಕೆ–ಕಾಂಬಿನೇಟರ್ ನಂತಹ ಯೋಜನೆಗಳು ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಮತ್ತು ಸೆಮಿಕಂಡಕ್ಟರ್ ಮೌಲ್ಯವರ್ಧಿತ ಸರಪಳಿಗೆ ಪೂರಕವಾಗುವ ಸ್ಟಾರ್ಟ್ ಅಪ್ ಮತ್ತು ಆವಿಷ್ಕಾರ ವ್ಯವಸ್ಥೆಯನ್ನು ಮತ್ತಷ್ಟು ಬಲಪಡಿಸುತ್ತವೆ. ಹೊಸ ಐಟಿ ನೀತಿ 2025–30ರ ಅಡಿಯಲ್ಲಿ ಸಾಫ್ಟ್ ವೇರ್ ರಫ್ತಿನಲ್ಲಿ ರೂ.11.5 ಲಕ್ಷ ಕೋಟಿಗಳ ಮಹತ್ವಾಕಾಂಕ್ಷೆಯ ಗುರಿ ಮತ್ತು ಜಾಗತಿಕ ಸಾಮರ್ಥ್ಯ ಕೇಂದ್ರಗಳ ನಿರಂತರ ವಿಸ್ತರಣೆಯೊಂದಿಗೆ ಕರ್ನಾಟಕವು ಭಾರತದ ಪ್ರಮುಖ ಡೀಪ್– ಟೆಕ್ ಮತ್ತು ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಆವಿಷ್ಕಾರ ಕೇಂದ್ರವಾಗಿ ತನ್ನ ಸ್ಥಾನವನ್ನು ಗಟ್ಟಿಗೊಳಿಸುತ್ತಿದೆ" ಎಂದು ಅವರು ಹೇಳಿದರು. "ವಿನ್ಯಾಸ, ಬಿಡಿಭಾಗಗಳು, ವ್ಯವಸ್ಥೆಗಳು, ಉಪಕರಣಗಳು ಮತ್ತು ಸೇವೆಗಳ ಸರಪಳಿ ಪಾಲುದಾರರನ್ನು ಒಳಗೊಂಡ ಪ್ರಬಲ ಸೆಮಿಕಂಡಕ್ಟರ್ ಮತ್ತು ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಉತ್ಪಾದನಾ ಪರಿಸರ ವ್ಯವಸ್ಥೆಯ ಬೆಳವಣಿಗೆಯನ್ನು ಈ ಯೋಜನೆಗಳು ವೇಗಗೊಳಿಸುತ್ತವೆ ಎಂದು ಐಇಎಸ್‌ಎ ನಂಬುತ್ತದೆ. ಈ ನಿಟ್ಟಿನಲ್ಲಿ ನಾವು ಕರ್ನಾಟಕ ಸರ್ಕಾರದೊಂದಿಗೆ ನಿಕಟವಾಗಿ ಕೆಲಸ ಮಾಡಲು ಎದುರು ನೋಡುತ್ತಿದ್ದೇವೆ. ಇದು ಕರ್ನಾಟಕ ಮತ್ತು ಭಾರತವನ್ನು ಜಾಗತಿಕ ಸೆಮಿಕಂಡಕ್ಟರ್ ಮತ್ತು ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಮೌಲ್ಯವರ್ಧಿತ ಸರಪಳಿಯ ಕೇಂದ್ರಭಾಗದಲ್ಲಿರಿಸಲಿದೆ" ಎಂದು ಶ್ರೀ ಚಂದಕ್ ಹೇಳಿದ್ದಾರೆ.

Date	17th March

Publication	Vijay Sporti
Quote By	Ashok Chandak

ಸೆಮಿಕಂಡಕ್ಟರ್, ಇಎಸ್‌ಡಿಎಂ ವಲಯದ ಕಂಪನಿಗಳಿಂದ ಸುಮಾರು ರೂ.45,000 ಕೋಟಿ ಹೂಡಿಕೆ

ಬೆಂಗಳೂರು:"ಕರ್ನಾಟಕ ಬಜೆಟ್ ಜಾಗತಿಕ ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಮತ್ತು ಸೆಮಿಕಂಡಕ್ಟರ್ ಉದ್ಯಮಕ್ಕೆ ಆಶಾದಾಯಕ ಸಂಕೇತವನ್ನು ಕಳುಹಿಸಿದೆ. ಇಎಸ್‌ಡಿಎಂ ಮತ್ತು ಸೆಮಿಕಂಡಕ್ಟರ್ ಹೂಡಿಕೆಗಳಿಗೆ ಅತ್ಯಂತ ಆಕರ್ಷಕ ತಾಣವಾಗಿ ಕರ್ನಾಟಕ ಹೊರಹೊಮ್ಮುತ್ತಿರುವುದು ಈಗ ಸ್ಪಷ್ಟವಾಗಿದ್ದು, ಅದಕ್ಕೆ ಪೂರಕವಾಗಿ ನೀತಿ ನಿರೂಪಣೆ ಮತ್ತು ತಂತ್ರಜ್ಞಾನ ನಾಯಕತ್ವ ಸಾಧಿಸುವ ಬದ್ಧತೆ ಹೊಂದಲಾಗಿದೆ. ಸೆಮಿಕಂಡಕ್ಟರ್ ಮತ್ತು ಇಎಸ್‌ಡಿಎಂ ವಲಯದ ಕಂಪನಿಗಳಿಂದ ಸುಮಾರು ರೂ.45,000 ಕೋಟಿ ಹೂಡಿಕೆಯ ನಿರೀಕ್ಷೆಯು, ಜಾಗತಿಕ ಮಟ್ಟದ ತಂತ್ರಜ್ಞಾನ ಸಂಸ್ಥೆಗಳು ಕರ್ನಾಟಕದ ಮೇಲೆ ಇಟ್ಟಿರುವ ಗಾಢವಾದ ವಿಶ್ವಾಸವನ್ನು ತೋರಿಸುತ್ತದೆ," ಎಂದು ಐಇಎಸ್‌ಎ ಅಧ್ಯಕ್ಷರಾದ ಅಶೋಕ್ ಚಂದಕ್ ತಿಳಿಸಿದ್ದಾರೆ.

ಬಜೆಟ್ ಕುರಿತು ಪ್ರತಿಕ್ರಿಯೆ ನೀಡಿದ ಅವರು, "ಅಷ್ಟೇ ಮಹತ್ವದ ಸಂಗತಿಯೆಂದರೆ, ಅತ್ಯಾಧುನಿಕ ತಂತ್ರಜ್ಞಾನಗಳು ಮತ್ತು ಪ್ರತಿಭೆಗಳ ಅಭಿವೃದ್ಧಿಗೆ ರಾಜ್ಯವು ಮಹತ್ವದ ಹೂಡಿಕೆಯನ್ನು ಮಾಡುತ್ತಿದೆ. ಇಸ್ರೋ ಮತ್ತು ಕಿಯೋನಿಕ್ಸ್ ಸಹಯೋಗದೊಂದಿಗೆ ಐಐಎಸ್ಸಿ ಅಡಿಯಲ್ಲಿ ಸ್ಥಾಪನೆಯಾಗಲಿರುವ ಬೆಂಗಳೂರು ರೋಬೊಟಿಕ್ಸ್ ಮತ್ತು ಎಐ ಇನ್ನೋವೇಶನ್ ಝೋನ್, ಐಐಎಬಿ, ಸಿ-ಕ್ಯಾಂಪ್ ಮತ್ತು ನಾಸ್ಕಾಂ ಸಹಯೋಗದೊಂದಿಗೆ ಆರಂಭವಾಗಲಿರುವ ಹಲವಾರು ಎಐ ಸೆಂಟರ್ ಆಫ್ ಎಕ್ಸಲೆನ್ಸ್ ಗಳು ಹಾಗೂ ಕರ್ನಾಟಕ ಕ್ವಾಂಟಮ್ ಟೆಕ್ನಾಲಜಿ ರೋಡ್ ಮ್ಯಾಪ್ ನಂತಹ ಯೋಜನೆಗಳು ಮುಂದಿನ ಪೀಳಿಗೆಯ ಸೆಮಿಕಂಡಕ್ಟರ್ ಮತ್ತು ಸುಧಾರಿತ ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಆವಿಷ್ಕಾರಕ್ಕೆ ಶಕ್ತಿ ತುಂಬುವ ಸಾಮರ್ಥ್ಯವನ್ನು ಹೊಂದಿವೆ" ಎಂದು ಹೇಳಿದರು. "ರೂ. 1,000 ಕೋಟಿ ವೆಚ್ಚದ ಲೋಕಲ್ ಎಕಾನಮಿ ಆಕ್ಸಿಲರೇಟರ್ ಪ್ರೋಗ್ರಾಂ (ಲೀಪ್), ಕೆಡಿಇಎಂ ಜೊತೆಗಿನ ಸೂಪರ್-100 ಉದ್ಯಮ- ಶೈಕ್ಷಣಿಕ ದತ್ತು ಕಾರ್ಯಕ್ರಮ ಮತ್ತು ಕೆ-ಕಾಂಬಿನೇಟರ್ ನಂತಹ ಯೋಜನೆಗಳು ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಮತ್ತು ಸೆಮಿಕಂಡಕ್ಟರ್ ಮೌಲ್ಯವರ್ಧಿತ ಸರಪಳಿಗೆ ಪೂರಕವಾಗುವ ಸ್ಟಾರ್ಟ್ ಅಪ್ ಮತ್ತು ಆವಿಷ್ಕಾರ ವ್ಯವಸ್ಥೆಯನ್ನು ಮತ್ತಷ್ಟು ಬಲಪಡಿಸುತ್ತವೆ. ಹೊಸ ಐಟಿ ನೀತಿ 2025-30ರ ಅಡಿಯಲ್ಲಿ ಸಾಫ್ಟ್ ವೇರ್ ರಫ್ತಿನಲ್ಲಿ ರೂ.11.5 ಲಕ್ಷ ಕೋಟಿಗಳ ಮಹತ್ವಾಕಾಂಕ್ಷೆಯ ಗುರಿ ಮತ್ತು ಜಾಗತಿಕ ಸಾಮರ್ಥ್ಯ ಕೇಂದ್ರಗಳ ನಿರಂತರ ವಿಸ್ತರಣೆಯೊಂದಿಗೆ ಕರ್ನಾಟಕವು ಭಾರತದ ಪ್ರಮುಖ ಡೀಪ್- ಟೆಕ್ ಮತ್ತು ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಆವಿಷ್ಕಾರ ಕೇಂದ್ರವಾಗಿ ತನ್ನ ಸ್ಥಾನವನ್ನು ಗಟ್ಟಿಗೊಳಿಸುತ್ತಿದೆ" ಎಂದು ಅವರು ಹೇಳಿದರು. "ವಿನ್ಯಾಸ, ಬಿಡಿಭಾಗಗಳು, ವ್ಯವಸ್ಥೆಗಳು, ಉಪಕರಣಗಳು ಮತ್ತು ಪೂರೈಕೆ ಸರಪಳಿ ಪಾಲುದಾರರನ್ನು ಒಳಗೊಂ ಪ್ರಬಲ ಸೆಮಿಕಂಡಕ್ಟರ್ ಮತ್ತು ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಉತ್ಪಾದನಾ ಪರಿಸರ ವ್ಯವಸ್ಥೆಯ ಬೆಳವಣಿಗೆಯನ್ನು ಈ ಯೋಜನೆಗಳು ವೇಗಗೊಳಿಸುತ್ತವೆ ಎಂದು ಐಇಎಸ್‌ಎ ನಂಬುತ್ತದೆ. ಈ ನಿಟ್ಟಿನಲ್ಲಿ ನಾವು ಕರ್ನಾಟಕ ಸರ್ಕಾರದೊಂದಿಗೆ ನಿಕಟವಾಗಿ ಕೆಲಸ ಮಾಡಲು ಎದುರು ನೋಡುತ್ತಿದ್ದೇವೆ. ಇದು ಕರ್ನಾಟಕ ಮತ್ತು ಭಾರತವನ್ನು ಜಾಗತಿಕ ಸೆಮಿಕಂಡಕ್ಟರ್ ಮತ್ತು ಎಲೆಕ್ಟ್ರಾನಿಕ್ಸ್ ಮೌಲ್ಯವರ್ಧಿತ ಸರಪಳಿಯ ಕೇಂದ್ರಭಾಗದಲ್ಲಿರಿಸಲಿದೆ" ಎಂದು ಶ್ರೀ ಚಂದಕ್ ಹೇಳಿದ್ದಾರೆ.

Karnataka Budget 2026
Bengaluru - Online

Date	06th March
Publication	Business News for profit
Quote By	Ashok Chandak

Karnataka Budget 2026 Reinforces the State's Leadership in Electronics, Semiconductors and Deep-Tech Innovation : IESA

By **team**

MAR 6, 2026

"The Karnataka Budget presented on 6th March 2026 sends a strong and reassuring signal to the global electronics and semiconductor industry. Karnataka's emergence as one of the most attractive destinations for ESDM and semiconductor investments is now backed by a clear policy vision and long-term commitment to technology leadership. The expectation of nearly ₹45,000 crore in investments from companies in the semiconductor and ESDM sector reflects the deep confidence that leading global technology players have placed in Karnataka's ecosystem, **Commented Ashok Chandak, president : IESA.**

Equally significant is the state's forward-looking investment in frontier technologies and talent development. Initiatives such as the Bangalore Robotics and AI Innovation Zone (BRAINz) under IISc in collaboration with ISRO and KEONICS, the establishment of multiple AI Centres of Excellence in partnership with IBAB, C-CAMP and NASSCOM, and the Karnataka Quantum Technology Roadmap demonstrate a strategic focus on building capabilities that will power the next generation of semiconductor and advanced electronics innovation.

The ₹1,000 crore Local Economy Accelerator Program (LEAP), the Super-100 Industry-Academia Adoption Programme with KDEM, and initiatives such as K-Combinator further strengthen the startup and innovation pipeline that will feed into the electronics and semiconductor value chain. Combined with the ambitious target of ₹11.5 lakh crore in software exports under the new IT Policy 2025-30 and the continued expansion of Global Capability Centres, Karnataka is reinforcing its position as India's premier deep–tech and electronics innovation hub.

IESA believes these initiatives will catalyse the growth of a robust semiconductor and electronics manufacturing ecosystem encompassing design, components, systems, equipment and supply chain partners. We look forward to working closely with the Government of Karnataka to translate these policy commitments into investment pipelines, industry clusters, skilling programmes and innovation platforms that will position Karnataka—and India—at the centre of the global semiconductor and electronics value chain." **Mr. Chandak Added.**

Date	06th March
Publication	Content Media Solution
Quote By	Ashok Chandak

Leadership in Electronics, Semiconductors and Deep-Tech Innovation : IESA

Neel Achary Mar 6, 2026 0

"The Karnataka Budget presented on 6th March 2026 sends a strong and reassuring signal to the global electronics and semiconductor industry. Karnataka's emergence as one of the most attractive destinations for ESDM and semiconductor investments is now backed by a clear policy vision and long-term commitment to technology leadership. The expectation of nearly ₹45,000 crore in investments from companies in the semiconductor and ESDM sector reflects the deep confidence that leading global technology players have placed in Karnataka's ecosystem, **Commented Ashok Chandak, president : IESA.**

Equally significant is the state's forward-looking investment in frontier technologies and talent development. Initiatives such as the Bangalore Robotics and AI Innovation Zone (BRAINz) under IISc in collaboration with ISRO and KEONICS, the establishment of multiple AI Centres of Excellence in partnership with IBAB, C-CAMP and NASSCOM, and the Karnataka Quantum Technology Roadmap demonstrate a strategic focus on building capabilities that will power the next generation of semiconductor and advanced electronics innovation.

The ₹1,000 crore Local Economy Accelerator Program (LEAP), the Super-100 Industry-Academia Adoption Programme with KDEM, and initiatives such as K-Combinator further strengthen the startup and innovation pipeline that will feed into the electronics and semiconductor value chain. Combined with the ambitious target of ₹11.5 lakh crore in software exports under the new IT Policy 2025-30 and the continued expansion of Global Capability Centres, Karnataka is reinforcing its position as India's premier deep–tech and electronics innovation hub.

Date	06th March
Publication	Business News this week
Quote By	Ashok Chandak

Karnataka Budget 2026 Reinforces the State's Leadership in Electronics, Semiconductors and Deep-Tech Innovation : IESA

March 6, 2026 Neel Achary business 0

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IESA believes these initiatives will catalyse the growth of a robust semiconductor and electronics manufacturing ecosystem encompassing design, components, systems, equipment and supply chain partners. We look forward to working closely with the Government of Karnataka to translate these policy commitments into investment pipelines, industry clusters, skilling programmes and innovation platforms that will position Karnataka—and India—at the centre of the global semiconductor and electronics value chain." **Mr. Chandak Added.**

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Publication	Biznews desk
Quote By	Ashok Chandak

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Posted on March 6, 2026 by admin

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Publication	Media bulletins
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on March 6, 2026 — Neel Achary

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